

Apr 82 HOUSE

First in Quality...First in Service • Custom, Semicustom and Standard IC's

Introduction

This Product Guide contains a complete summary of technical data and information covering Exar's full line of IC products. Each of the products presented in the Product Guide covers a wide range of applications which will greatly simplify most system designs. To help the designer find the right devices for his applications, the products listed are grouped by function and a convenient cross-reference chart is provided which shows Exar's direct replacement for a number of popular industry products.

EXPERIENCE AND PRODUCTS

Exar's innovativeness, product quality and responsiveness to customer needs have been the key to its success. Exar today offers a broad line of linear and interface circuits. In the field of standard linear IC products, Exar has extended its circuit technological leadership into the areas of communications and control circuits. Today Exar has one of the most complete lines of IC oscillators, timing circuits and phase-locked loops in the industry. Exar also manufactures a large family of telecommunication circuits such as tone decoders, compandors, modulators, PCM repeaters and FSK Modem Circuits. In the field of industrial control circuits, Exar manufactures a broad line of quad and dual operational amplifiers, voltage regulators, radio-control and servo driver IC's, and power control circuits.

Exar's experience and expertise in the area of bipolar IC technology extends both into custom and standard IC products. In the area of custom IC's, Exar has designed, developed, and manufactured a wide range of full-custom monolithic circuits, particularly for applications in the areas of telecommunications, consumer electronics, and industrial controls.

In addition to the full-custom capability, Exar also offers a unique semi-custom IC development capability for low to medium-volume custom circuits. This semi-custom program, is intended for those customers seeking cost-effective solutions to reduce component count and board size in order to compete more effectively in a changing marketplace. The program allows a customized monolithic IC to be developed with a turnaround time of several weeks at a small fraction of the cost of a full-custom development program.

EXCELLENCE IN ENGINEERING

Exar quality starts in Engineering where highly qualified people are backed up with the advanced instruments and facilities needed for design and manufacture of custom, semicustom and standard integrated circuits. Exar's engineering and facilities are geared to handle all three classes of IC design: (1) semi-custom design programs using Exar's bipolar and I^2L master chips; (2) full-custom IC design; (3) development and high-volume production of standard products.

Exar reserves the right to make changes at any time in order to improve design and to supply the best product possible.

Some of the challenging and complex development programs successfully completed by Exar include analog compandors and PCM repeaters for telecommunication, electronic fuelinjection, anti-skid braking systems and voltage regulators for automotive electronics, digital voltmeter circuits, 40-MHz frequency synthesizers, high-current and high-voltage display and relay driver ICs, and many others.

NEW TECHNOLOGIES

Through company sponsored research and development activities, Exar constantly stays abreast of all technology areas related to changing customer needs and requirements. Exar has recently completed development efforts in Integrated Injection Logic (I²L) technology, which offers unique advantages in the area of low-power, high-density logic arrays. Exar has a complete design engineering group dedicated to this new technology, and is currently supplying over twenty different custom and semi-custom I²L products.

FIRST IN QUALITY

From incoming inspection of all materials to the final test of the finished goods, Exar performs sample testing of each lot to ensure that every product meets Exar's high quality standards. Exar's manufacturing process is inspected or tested in accordance with its own stringent Quality Assurance Program, which is in compliance with MIL-Q-9858A. Additional special screening and testing can be negotiated to meet individual customer requirements.

Throughout the wafer fab and assembly process, the latest scientific instruments, such as scanning electron microscopes, are used for inspection, and modern automated equipment is used for wafer probe, AC, DC, and functional testing. Environmental and burn-in testing of finished products is also done in-house. For special environmental or high reliability burn-in tests outside testing laboratories are used to complement Exar's own extensive in-house facilities.

FIRST IN SERVICE

Exar has the ability and flexibility to serve the customer in a variety of ways from wafer fabrication to full parametric selection of assembled units for individual customer requirements. Special marking, special packaging and military screening are only a few of the service options available from Exar. We are certain that Exar's service is flexible enough to satisfy 99% of your needs. The company has a large staff of Applications Engineers to assist the customer in the use of the product and to handle any request, large or small.

Exar cannot assume responsibility for any circuits shown or represented, as being free from patent infringement.

Table of Contents

	Pa	ıge
INDUSTRY-WIDE PRODUCT CROSS REFERENCE		1
APPLICATIONS GUIDE		2

LIST OF PRODUCTS

Phase-Locked L	00ps	
XR-210	FSK Modulator/Demodulator	6
XR-215	High-Frequency Phase-Locked Loop	6
XR-2211	FSK Demodulator/Tone Decoder	7
XR-2212	Precision Phase-Locked Loop	7
////- <i>2212</i>		
Tone Decoders		
XR-567	Monolithic Tone Decoder	8
XR-567		
XR-2567	Micropower Tone Decoder	
AK-230/	Dual Monolithic Tone Decoder	9
Engetten Comer		
Function Gener		0
XR-205	Monolithic Waveform Generator	
XR-2206	Monolithic Function Generator	
XR-2207	Voltage-Controlled Oscillator	
XR-2209	Precision Oscillator	
XR-8038	Precision Waveform Generator	11
Timing Circuits		
XR-320	Monolithic Timing Circuit	
XR-555	Timing Circuit	
XR-L555	Micropower Timing Circuit	13
XR-556	Dual Timer	13
XR-L556	Dual Micropower Timer	14
XR-558/559	Quad Timer Circuit	
XR-2240	Programmable Timer/Counter	
XR-2242	Long-Range Timer	
XR-2556	Dual Timing Circuit	
Multipliers and	Modulators	
XR-2208	Operational Multiplier	16
XR-2228	Multiplier/Detector	
711(-2220		1 /
Operational Am	nlifiers	
XR-082	Dual BIFET Operational Amplifier	17
XR-082 XR-083	Dual BIFET Operational Amplifier	
XR-085	Quad BIFET Operational Amplifier	
XR-084 XR-094	Quad Programmable BIFET Operational Amplifier	
XR-094 XR-095	Quad Programmable BIFET Operational Amplifier	
XR-095 XR-096	Quad Programmable BIFET Operational Amplifier	
XR-146/246		20
AR-140/240	Programmable Quad Operational Amplifier	20
VD 2402/25		20
XR-3403/35		21
VD 4126	Quad Operational Amplifier	
XR-4136	Quad Operational Amplifier	
XR-4202	Programmable Quad Operational Amplifier	
XR-4212	Quad Operational Amplifier	
XR-4741	Quad Operational Amplifier	23
XR-1458/45		
	Dual Operational Amplifier	
XR-4739	Dual Low-Noise Operational Amplifier	
XR-5532	Dual Low-Noise Operational Amplifier	
XR-5533	Dual Low-Noise Operational Amplifier	25
XR-5534	Low-Noise Operational Amplifier	

Table of Contents

		Page
Voltage Regula		
XR-1468/15		
	Dual-Polarity Tracking Voltage Regulator	
XR-4194	Dual-Tracking Voltage Regulator	
XR-4195	±15V Dual-Tracking Voltage Regulator	27
XR-1524/25	Pulse Width Modulating Regulator	27
		21
Special Function	ns	
XR-S200	Multi-Function Integrated Circuit	28
XR-4151	Voltage-to-Frequency Converter	
XR-2264/22		
	Pulse-Proportional Servo Circuit	
XR-2266	Monolithic Servo Controller	
XR-1310	Stereo Demodulator	
XR-13600	Dual Operational Transconductance Amplifier	30
D'aulas D'		
Display Drivers		21
XR-2271	Fluorescent Display Driver	
XR-2272 XR-2276	High-Voltage 7-Digit Display Driver	
XR-2276 XR-2277/22	Bar-Graph Display Generator	52
AR-2211/22	Bar-Graph Display Generators	32
XR-2279	Dot or Bar-Graph Display Generator	
XR-2284	High Voltage AC Plasma Display Driver	
XR-2288	High Voltage AC Plasma Display Driver	
XR-6118/61	28	
	Fluorescent Display Driver	34
High Current D		
XR-2200	Hammer Driver	35
XR-2201/22	202/2203/2204	25
	High-Voltage, High-Current Darlington Transistor Arrays	35
Line Interface	Circuite	
XR-1488	Quad Line Driver	36
XR-1489A	Quad Line Briver	
Telcommunica	tion Circuits	
XR-2216	Monolithic Compandor	37
XR-C240	Monolithic PCM Repeater	
XR-C262	High-Performance PCM Repeater	
XR-C277	Low-Voltage PCM Repeater	38
		20
	CHIPS FOR HYBRID ASSEMBLIES	39
	A AND CUSTOM PROGRAMS	40
Semi-Custor	n Bipolar Program	40
	1 Development	
	SURANCE STANDARDS	
	DERING INFORMATION	
	N NOTES	
ORDERING T	ECHNICAL LITERATURE FROM EXAR	. 48
FOREIGN SA	LES OFFICES AND REPRESENTATIVES	. 49
AUTHORIZEI	OSTOCKING DISTRIBUTORS	. 50
AUTHORIZEI	OREPRESENTATIVES	. 51

Industry-wide Product Cross Reference

XR Devices	Fairchild	Intersil	Motorola	National	Raytheon	Signetics	Silicon General	Sprague	Texas Instruments
082 083 084									TL082 TL083 TL084
146 246 346 346-2 555	UA555	NE555	MC1455	LM146 LM246 LM346 LM346-2 LM555	RC555	NE555	SG555		SN72555
L555 556 L556 558 559	UA556	NE556	MC3456	LM556	RC556	NEL555 NE556 NEL556 NE558 NE559	SG556		
567 1310 1468			MC1310 MC1468	LM567 LM1310		NE567 MC1310	SG1468	ULN2210	SN76115N
1488	UA1488		MC1488	LM1488	RC1488	MC1488	SG1488		MC1488 SN75188
1489	UA1489A		MC1489A	LM1489A	RC1489A	MC1489A	SG1489A		SN75189A
1524 2201	UA9665		MC1411	LM1524		ULN2001	SG1524 SG2001	ULN2001	SG1524 ULN2001 SN75466
2202	UA9666	1	MC1412			ULN2002	SG2002	ULN2002	ULN2002 SN75467
2203	UA9667		MC1413			ULN2003	SG2003	ULN2003	ULN2003 SN75468
2204	UA9668		MC1416			ULN2004		ULN2004	ULN2004 SN75469
2206 2207 2211 2240 2524	UA2240	ICL8240	MC14541	LM2524	RC2207 RC2211	SG2524	SG2206 SG2524		UA2240
2567 3403 3503 3524 4136	UA3403 UA3503 UA4136		MC3403 MC3503	LM3524	RC2567 RC3403 RC3503 RC4136	SG3524	SG3503 SG3524		MC3403 MC3503 SG3524 RC4136
4151 4194 4195 4558 4739	UA4151 UA4558 UA739		MC4558	LM1458	RC4151 RC4194 RC4195 RC4558 RC4739	MC1458	SG4194 SG1458		RC4558 SN72558
4741 5532 5533 5534 6118		LM348	MC4741	LM348	HA4741-5	NE5532 NE5533 NE5534		ULN6118	NE5534
6128 8038 13600		ICL8038		LM13600				ULN6128	

1

Applications Guide

Exar's line of monolithic IC products cover a wide range of applications. This *Applications Guide* is intended as a brief selection guide for the IC user, to assist him in finding the Exar product most suited to his application.

The application categories, or classes, are listed in alphabetical order, dictionary style, to allow the user to locate the product he needs at a glance. In certain applications, *two* of Exar's products used in combination may be necessary to perform the complete function. In such a case, these products are grouped together as a pair. For example, to make a complete FSK Modem may require the XR-2206 Modulator and the XR-2211 Decoder. Thus, in the Applications Guide shown below, both of these products will be grouped under the Modem category as XR-2206/XR-2211.

In many of the applications, more than one product type is recommended. In such cases, the user can choose the device best suited to his specific application by either consulting with Exar's Applications Department, or by reviewing the electrical specifications of individual devices involved.

APPLICATION	RECOMMENDED EXAR PRODUCT
Active Filters	XR-084, XR-094, XR-096, XR-346, XR-3403, XR-4202
Acoustical Couplers (Also See Modems)	XR-2206, XR-2207, XR-2211
A/D Conversion (Pulse Counting Type)	XR-2240
Amplitude Detection Phase-Locked AM Detection Synchronous AM Detection Amplitude Level Detection	XR-215/XR-2228, XR-2212/XR2228 XR-S200, XR-2208, XR-2228 XR-2276, XR-2277
Amplitude Level Detection Amplitude Modulated Oscillator Crystal Controlled AM Oscillator	XR-205, XR-2206 XR-S200, XR-205
Amplitude Modulation	XR-2206, XR-2208, XR-2228, XR-13600
Analog Computation Analog Multiplication/Division Analog Square/Square-Root Operation	XR-2208, XR-2228 XR-2208
Analog-To-Frequency Conversion	XR-2209, XR-4151
Analog Sample-Hold	XR-13600/XR-082
Analog Semi-Custom Design (Master Chips)	XR-A100, XR-B100, XR-C100, XR-D100 XR-F100, XR-G100, XR-X100
Appliance Timing	XR-555, XR-556, XR-558, XR-559, XR-2240, XR-2242
Audio Amplifier/Preamp	XR-5532, XR-5534
Audio Level Detector	XR-2276, XR-2279
Automatic Gain Control (AGC)	XR-2208, XR-2216, XR-2228, XR-13600

—A—

APPLICATION	RECOMMENDED EXAR PRODUCT
Bar Graph Display	XR-2276, XR-2277
Battery Charger Timing	XR-2242
Battery Operated Instruments (Low Power) Timing Tone Detection	XR-L555, XR-L556 XR-L567
Bit-Pattern Generation	XR-2240

-C-

-B-

APPLICATION	RECOMMENDED EXAR PRODUCT
Carrier Detection (Also See AM and	
Tone Detection) High Frequency (>1 MHz) Low Frequency (<1 MHz)	XR-215/XR-2228 XR-567, XR-2211, XR-2567
Low Power	XR-L567
Carrier-Tone Transceiver	XR-2567
Clock Generation (See Also Oscillators) Low Frequency (<1 MHz)	XR-555, XR-2209, XR-2242
Low Power	XR-L555, XR-L556
High Frequency Phase-Locked	XR-205 XR-215, XR-2212
Clock Extraction Phase-Locked	XR-210, XR-215, XR-2212
PCM Signal Clock	XR-C262, XR-C277
Clock Pattern Generation	XR-2240
Clock Synchronization High Frequency (>1 MHz) Low Frequency (<1 MHz)	XR-210, XR-215 XR-2212
Compandor (Speech/Data)	XR-2216
Current-to-Frequency Converter	XR-2206, XR-2207, XR-2209
D	

APPLICATION	RECOMMENDED EXAR PRODUCT
Darlington Arrays (High-Current, High-Voltage)	XR-2200, XR-2201, XR-2202, XR-2203, XR-2204
Data Synchronization High Frequency (>1 MHz) Low Frequency (<1 MHz)	XR-210, XR-215 XR-2212
DC-DC Converter (Also See Switching Regulators)	XR-1524, XR-2524, XR-3524
Detector FM FSK Tone Amplitude Level Amplitude Modulation	XR-215, XR-2212 XR-210, XR-2211 XR-567, XR-L567, XR-2211, XR-2567 XR-2276, XR-2279 XR-2208

Differential Multiplier	XR-2228
Digital Sample-Hold	XR-2240
Digital Semi-Custom Design (I ² L Gate Arrays)	
Complete Digital Design	XR-200, XR-300, XR-500
Combined Analog/Digital Design	XR-400
Display Driver Fluorescent Bar-Graph	XR-2271, XR-2272, XR-6118, XR-6128 XR-2276, XR-2277 XR-2278 XR-2279
Plasma Displays:	XR-2284, XR-2288
Division (Analog)	XR-2208
Division (Frequency)	XR-2240
Dual Operational Amplifiers Dual-741 Type Low Noise Bifet	XR-1458, XR-4558, XR-4739 XR-5532, XR-5533 XR-082, XR-083
Transconductance	XR-13600
Dual Oscillator Low Power	XR-556, XR-2556, XR-2567 XR-L556
Dual Tone Detector	XR-2567
— <u> </u>	
APPLICATION	RECOMMENDED EXAR PRODUCT
Electronic Gain Control	XR-2208, XR-2216, XR-2228, XR-13600
Expander (Speech/D-t-)	XR-2216
Expandor (Speech/Data)	
Expandor (Speech/Data)	
—F— APPLICATION	RECOMMENDED EXAR PRODUCT
—F—	
— F — APPLICATION Filters Active Filters Tracking Filters (Phase-Locked) Fluorescent Display Driver Medium Voltage (≤50V) High Voltage (>50V) Bar-Graph Display	EXAR PRODUCT XR-084, XR-094, XR-346, XR-3403, XR-4202 XR-5200, XR-215,
— F— APPLICATION Filters Active Filters Tracking Filters (Phase-Locked) Fluorescent Display Driver Medium Voltage (≤50V) High Voltage (>50V)	EXAR PRODUCT XR-084, XR-094, XR-346, XR-3403, XR-4202 XR-5200, XR-215, XR-2212 XR-2271, XR-2272 XR-6118, XR-6128
F APPLICATION Filters Active Filters Tracking Filters (Phase-Locked) Fluorescent Display Driver Medium Voltage (≤50V) High Voltage (≤50V) Bar-Graph Display Frequency Detection (Also See Tone Detection) High Frequency (>1 MHz) Low Frequency (<1 MHz)	EXAR PRODUCT XR-084, XR-094, XR-346, XR-3403, XR-4202 XR-5200, XR-215, XR-2212 XR-2271, XR-2272 XR-6118, XR-6128 XR-2276, XR-2279 XR-215/XR-2228 XR-567, XR-2211
F APPLICATION Filters Active Filters Tracking Filters (Phase-Locked) Fluorescent Display Driver Medium Voltage (≤50V) High Voltage (≤50V) Bar-Graph Display Frequency Detection (Also See Tone Detection) High Frequency (>1 MHz) Low Frequency (<1 MHz) Multiple Frequency Frequency Discriminator (Also See F/V Converter) High Frequency (>1 MHz)	EXAR PRODUCT XR-084, XR-094, XR-346, XR-3403, XR-4202 XR-5200, XR-215, XR-2212 XR-2271, XR-2272 XR-6118, XR-6128 XR-2276, XR-2279 XR-215/XR-2228 XR-567, XR-2211 XR-2567 XR-215

Frequency Translation High Frequency (>1 MHz) Low Frequency (<1 MHz)	XR-215/XR-2228 XR-2212/XR-2228
Frequency/Voltage (F/V) Converter Wide Band Narrow Band	XR-4151 XR-2212
FSK Detection (Decoding) High Frequency (>1 MHz) Low Frequency (<1 MHz)	XR-210 XR-2211
FSK Generation (Encoding) High Frequency (>1 MHz) Low Frequency (<1 MHz) Sinusoidal Output Multiple Frequency Levels	XR-210 XR-2206, XR-2207 XR-2206 XR-2207
FSK Modem (Modulator/ Demodulator)	XR-2211/XR-2206, XR-2211/XR-2207

—G—

APPLICATION	RECOMMENDED EXAR PRODUCT
Gate Arrays (I ² L)–(Also See Digital Semi-Custom)	XR-200, XR-300, XR-400, XR-500
Generator (See Function Generators)	XR-205, XR-2206, XR-8038
Ground-Sensing Op Amps	XR-3403
Gyrator Design	XR-094, XR-346, XR-3403, XR-4202, XR-13600

—H—

APPLICATION	RECOMMENDED EXAR PRODUCT
Hammer Driver (Also See High Current Drivers)	XR-2200, XR-2201, XR-2202, XR-2203, XR-2204
High Voltage Driver	XR-6118, XR-6128 XR-2284, XR-2288

|--|--|

APPLICATION	RECOMMENDED EXAR PRODUCT
Indicator, Amplitude (Also See AM Detector, Level Detector)	XR-2208, XR-2228, XR-2276 XR-2279
Indicator, Frequency (Also See Frequency Detector)	XR-215, XR-2212, XR-4151
Intercom	XR-2206/XR-2211, XR-2567
Interval Timing	XR-555, XR-L555, XR-556, XR-L556, XR-558, XR-559

—L—

APPLICATION	RECOMMENDED EXAR PRODUCT
LED Driver	XR-2200, XR-2201, XR-2202, XR-2203, XR-2204
Linear Ramp Generation	XR-320, XR-2207
Linear Sweep Oscillator	XR-2206, XR-2207, XR-2209
Line Compandor	XR-2216
Line Driver (RS-232C Spec)	XR-1488
Line Receiver (RS-232C Spec)	XR-1489A

APPLICATION	RECOMMENDED EXAR PRODUCT
Filters Active Filters	XR-084, XR-094, XR-346, XR-3403,
Tracking Filters (Phase-Locked)	XR-4202 XR-S200, XR-215, XR-2212
Fluorescent Display Driver Medium Voltage (≤50V)	XR-2271, XR-2272
High Voltage (>50V) Bar-Graph Display	XR-6118, XR-6128 XR-2276, XR-2279
Frequency Detection (Also See Tone Detection)	
High Frequency (>1 MHz) Low Frequency (<1 MHz) Multiple Frequency	XR-215/XR-2228 XR-567, XR-2211 XR-2567
Frequency Discriminator (Also See	
F/V Converter) High Frequency (>1 MHz) Low Frequency (<1 MHz)	XR-215 XR-2212, XR-4151
Frequency Division	XR-320, XR-555, XR-2240, XR-2242
Frequency Doubling	XR-2208, XR-2228
FM Detection High Frequency (>1 MHz) Low Frequency (<1 MHz)	XR-215 XR-215, XR-2212
FM Generation High Frequency (>1 MHz) Low Frequency (<1 MHz)	XR-S200, XR-205 XR-2206, XR-2207, XR-2209, XR-8038
Frequency Multiplication (Synthesis) High Frequency (>1 MHz) Low Frequency (<1 MHz)	XR-S200, XR-215 XR-2212

Long Delay Generation	XR-2242
Low Power Oscillator	XR-L555
Low Power PLL	XR-L567
Low Power Timer	XR-L555, XR-L556
Low Voltage Timer/Oscillator	XR-L555, XR-L556

APPLICATION	RECOMMENDED EXAR PRODUCT
Micropower Circuits (Also See Low Power)	
Micropower Oscillator Micropower Tone Decoder (PLL) Micropower Timer	XR-L555, XR-L556 XR-L567 XR-L555, XR-L556
Missing Pulse Detection	XR-320, XR-555, XR-L555
Modem Filter Design	XR-346, XR-3403, XR-4202
Modem (Frequency-Shift Keyed)	XR-210, XR-2206, XR-2207, XR-2211
Modulators (Also See Multipliers) Amplitude Modulator FSK Modulator Frequency Modulator Phase Modulator	XR-2212 XR-2206, XR-2207 XR-205, XR-2206, XR-2209 XR-2212
Motor Speed Control	XR-2208, XR-2212
Multi-Function PLL	XR-S200
Multiplier, Analog	XR-2208, XR-2228

-0—

APPLICATION	RECOMMENDED EXAR PRODUCT
Operational Amplifiers	
Single Op Amp	XR-5534
Dual Op Amp	XR-082, XR-083,
	XR-1458, XR-4558, XR-4739
Quad Op Amp	XR-084, XR-3403, XR-4136, XR-4212, XR-4741
Programmable Op Amp	XR-094, XR-095, XR-096, XR-346,
	XR-4202
Ground Sensing Quad Op Amp	XR-3403
Ultra Low Noise Op Amp	XR-5532, XR-5333, XR-5534
Bifet Op Amps	
Dual Bifet	XR-082, XR-083
Quad Bifet	XR-084
Programmable Bifet	XR-094, XR-095, XR-096
Operational Transconductance Amplifier (OTA)	XR-13600
Oscillators (Also See Function Generators)	
High Frequency Oscillator (>1 MHz)	XR-205, XR-210, XR-215
Low Frequency Oscillator (<1 MHz)	XR-2206, XR-2207, XR-2209, XR-8038
High Current Output Oscillator	XR-567
Low Cost Oscillator	XR-555, XR-L555
Low Power Oscillator (Single)	XR-L555, XR-L567
Low Power Oscillator	XR-L-556
Quad Oscillator	XR-558, XR-559
Sinusoidal Output	XR-205, XR-2206, XR-8038
FSK Keyed Oscillator	XR-2206, XR-2207
Oscillator with Quadrature Outputs	XR-2212

RECOMMENDED **APPLICATION** EXAR PRODUCT XR-C240, XR-C262, PCM Repeater (See Regenerator) XR-C277 XR-2208, XR-2228 Phase-Comparator (Phase-Detector) Phase-Locked Loop High Frequency (>1 MHz) XR-S200, XR-210, XR-215 XR-567, XR-L567, Low Frequency (<1 MHz) XR-2567, XR-2211, XR-2212 Ultra-Stable XR-2211, XR-2212 FM Detector XR-215, XR-2212 FSK Detector XR-210, XR-2211 **Tone Detector** XR-567, XR-L567, XR-2567 Low Power XR-L567 XR-215/XR-2228, AM Detector XR-2212/XR-2228 Stereo Decoder XR-1310 Plasma Display Driver XR-2284, XR-2288 XR-320, XR-555, Power-On-Reset XR-L555 XR-2206, XR-2209 Precision Oscillator Precision PLL XR-2212 XR-2206/XR-2211, Process Controller XR-2240, XR-4151 Programmable Op Amp (Also See Op Amps) Quad Bipolar XR-346, XR-346-2, XR-4202 XR-094, XR-095 Quad Bifet XR-096 Programmable Oscillator XR-2206, XR-2207 Programmable Timer XR-2240 XR-205, XR-2206, PSK Generation (Bi-phase) XR-2228 Pulse-Blanking XR-556, XR-2556 XR-C240, XR-C262, Pulse-Code Modulation (PCM) Regenerator XR-C277 **Pulse** Counting XR-2240 **Pulse Generation** XR-320, XR-555, XR-L555, XR-556 Pulse-Position Modulation (PPM) XR-320 XR-2264, XR-2265, Pulse-Proportioned Servo Controller XR-2266 XR-555, XR-556, **Pulse Shaping** XR-558, XR-559 **Pulse Stretching** XR-320, XR-555, XR-556 Pulse-Width Modulation (PWM) XR-320, XR-555 XR-1524, XR-2524, Pulse-Width Modulating Regulator XR-3524 _Q_ RECOMMENDED APPLICATION **EXAR PRODUCT** XR-2208, XR-2228 Quadrature AM Detector Quadrature-Output Oscillator XR-2212

APPLICATION

R

RECOMMENDED EXAR PRODUCT

Radio-Controlled Servo Driver	XR-2264, XR-2265, XR-2266
Radio-FM I.F. Demodulation -AM I.F. Detection	XR-215 XR-2228
Relay Driver (Also See Hammer Driver)	XR-2200, XR-2201, XR-2202, XR-2203, XR-2204
Remote-Control Timer/Sequencer	XR-L555, XR-L556, XR-2240
Remote-Control Transceiver	XR-567, XR-L567, XR-2567
Reset Controller (Also See Power-On Reset)	XR-L555, XR-L556
	XK-L355, XK-L550

APPLICATION	RECOMMENDED EXAR PRODUCT
Sample-Hold Amplifier (Also See Bifet Op Amps)	XR-082, XR-084
Saw-Tooth Generator	XR-320, XR-2207
Semi-Custom Design	AR-520, AR-2207
Digital (I ² L) Master Chips	XR-A100, XR-B100, XR-C100, XR-D100, XR-F100, XR-X100 XR-200, XR-300, XR-400, XR-500
Sequential Timing	XR-556, XR-L556, XR-558, XR-559
Sequential Tone Decoding	XR-567, XR-L567, XR-2567
Servo Controller/Driver	XR-2264, XR-2266
Signal Conditioning High Frequency (>1MHz)	XR-S200, XR-215, XR-2212
Low Frequency (<1 MHz)	XR-2212
Simultaneous AM/FM Detection	XR-215/XR-2228, XR-2212/XR-2228
Simultaneous AM/FM Generation	XR-205, XR-2206
Sine Wave Converter	XR-2212/XR-2228
Sine Wave Generator	XR-205, XR-2206, XR-8038
Solenoid Driver (Also See Relay Driver)	XR-2200, XR-2201, XR-2202, XR-2203, XR-2204
Speech Compandor	XR-2216
Square-Root Extraction	XR-2208
Squaring (Analog)	XR-2208, XR-2228
Stable PLL	XR-2211, XR-2212
Stereo Demodulator (Decoder)	XR-1310
Suppressed Carrier AM Generator	XR-205, XR-2206, XR-2208, XR-2228
Sweep Generation (Also See Saw-Tooth Generation)	XR-320, XR-2207
Synchronization (Clock Frequency)	XR-215, XR-2212
Synchronous AM Detection	XR-215/XR-2228, XR-2212/XR-2228
T	

APPLICATION	RECOMMENDED EXAR PRODUCT
Telecommunication Circuits	XR-C240, XR-C262,
PCM Repeater (T-1 Type)	XR-C277

Speech Compandor	XR-2216
Tone Decoder (PLL Type)	XR-567, XR-L567,
	XR-2211, XR-2567
Tone Encoder	XR-2206, XR-2207
Timing Circuits (Timers)	
General Purpose Timers - Single	XR-320, XR-555
General Purpose Timers - Dual	XR-556, XR-2556
General Purpose Timers - Quad	XR-558, XR-559
Low Power Timers	XR-L555, XR-L556
Long Delay Timer	XR-2242
Programmable Timer	XR-2240
Tone Decoder (PLL Type)	
General Purpose - Single	XR-567
General Purpose - Dual	XR-2567
Precision	XR-2211
Low Power	XR-L567
Tone Encoder	XR-2206, XR-2207
Tracking Filter	
High Frequency (>1MHz)	XR-S200, XR-215
Low Frequency (<1 MHz)	XR-2212
Tracking Regulator	XR-1468, XR-4194,
	XR-4195
Transceiver (Wireless Intercom)	XR-2567
Triangle-to-Sine Wave Converter	XR-2208, XR-2228
Triangle-Wave Oscillator	XR-2206, XR-2207,
-	XR-2209, XR-8038
TV Sound Detection	XR-215

-U-

APPLICATION	RECOMMENDED EXAR PRODUCT
Ultra-Low Frequency Oscillator	XR-2242
Ultra-Sonic Remote Control	XR-567, XR-2211, XR-2567
Universal Sine Wave Converter	XR-2212/XR-2228

-v--

APPLICATION	RECOMMENDED EXAR PRODUCT
Voltage-Controlled Amplifier	XR-2208, XR-2228, XR-13600
Voltage-Controlled Oscillator (VCO) High Frequency (>1 MHz) Low Frequency (<1 MHz) Ultra-Stable Sinusoidal Output Wide Linear Sweep	XR-S200, XR-205 XR-2206, XR-2207, XR-2209, XR-8038 XR-2206, XR-2207, XR-2209 XR-2206, XR-8038 XR-2207, XR-2209
Voltage-to-Current Conversion	XR-13600
Voltage-to-Frequency (V/F) Conversion	XR-2209, XR-4151



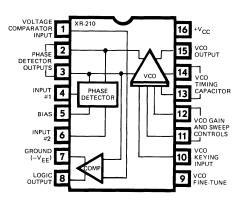
APPLICATION	RECOMMENDED EXAR PRODUCT
Waveform Generator (Also See Oscillators) High Frequency (>1 MHz) Low Frequency (<1 MHz)	XR-205 XR-2206, XR-2209, XR-8038
Waveform Shaping/Modulation	XR-2208, XR-2228
Wide Band Discriminator (FM) High Frequency (>1 MHz) Low Frequency (<1 MHz)	XR-S200, XR-215 XR-2212, XR-4151
Wireless Intercom	XR-215, XR-567, XR-2212

Phase-Locked Loops

XR-210 FSK MODULATOR/ DEMODULATOR

The XR-210 is a highly versatile monolithic phase-locked loop system especially designed for data communications. It is particularly well suited for FSK modulation/demodulation (MODEM) applications, frequency synthesis, tracking filters and tone decoding. The XR-210 operates over a power supply range of 5V to 26V and over a frequency band of 0.5 Hz to 20 MHz. The circuit can accommodate analog signals between 300 μ V and 3V and can interface with conventional DTL, TTL, and ECL logic families.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Digital Programming Capability RS-232C Compatible Demodulator Output ON-OFF Keying and Sweep Capability Wide Tracking Range: Adjustable from ±1% to ±50% Good Temperature Stability (200 ppm/°C) High Current Logic Output (50 mA) Independent "Mark" and "Space" Frequency Adjustment VCO Duty Cycle Control

APPLICATIONS

FSK Demodulation FSK Generation Data Synchronization Frequency Synthesis FM and Sweep Generation Tracking Filter Signal Conditioning Tone Decoding FM Detection Wideband Discrimination

ORDER INFORMATION

Part Number	Package
XR-210M	Ceramic
XR-210CN	Ceramic

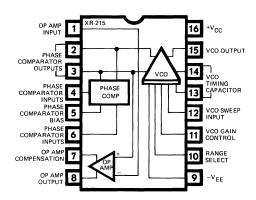
Operating Temperature

 -55° C to $+125^{\circ}$ C 0°C to $+75^{\circ}$ C

XR-215 HIGH-FREQUENCY PHASE-LOCKED LOOP

The XR-215 is a highly versatile monolithic phase-locked loop (PPL) system designed for a wide variety of applications in both analog and digital communication systems. It is especially well suited for FM demodulation, frequency synthesis and tracking filter applications. The XR-215 operates over a power supply voltage ranging from 5V to 26V and has a wide frequency band of 0.5 Hz to 35 MHz. It can interface with conventional DTL, TTL, and ECL logic families.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Wide Frequency Range: 0.5 Hz to 35 MHz Wide Supply Voltage Range: 5V to 26V Digital Programming Capability DTL, TTL, and ECL Logic Compatibility Wide Dynamic Range: 300μ V to 3V ON-OFF Keying and Sweep Capability Wide Tracking Range: Adjustable from ±1% to ±50% High-Quality FM Detection: Distortion 0.15% Signal/Noise 65 dB

APPLICATIONS

FM Demodulation Frequency Synthesis FSK Coding/Decoding (MODEM) Tracking Filters Signal Conditioning FM, FSK, and Sweep Generation Crystal Controlled Detection Wideband Frequency Discrimination Voltage-to-Frequency Conversion

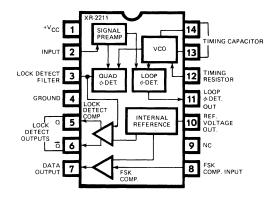
Part Number	Package	Operating Temperature
XR-215CN	Ceramic	0°C to +75°C

Phase-Locked Loops

XR-2211 FSK DEMODULATOR/ TONE DECODER

The XR-2211 is a monolithic phase-locked loop system especially designed for data communications and is particularly well-suited for FSK modem applications. It has a supply voltage range of 4.5V to 20V and a wide frequency range of 0.01 Hz to 300 kHz. The circuit accommodates analog signals between 2 mV and 3V and interfaces with conventional DTL, TTL, and ECL logic families. The XR-2211 consists of a basic PLL for tracking an input signal within the passband, a quadrature phase detector for carrier detection, and an FSK voltage comparator for FSK demodulation. Independent external components set center frequency, bandwidth, and output delay.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Wide Frequency Range0.01 Hz to 300 kHzWide Supply Voltage Range4.5V to 20VDDT/TTL/ECL Logic CompatibilityFSK Demodulation, with Carrier-DetectionWide Dynamic Range2 mV to 3 VrmsAdjustable Tracking Range (±1% to ±80%)20 ppm/°C, Typical

APPLICATIONS

FSK Demodulation Data Synchronization Tone Decoding FM Detection Carrier Detection

ORDER INFORMATION

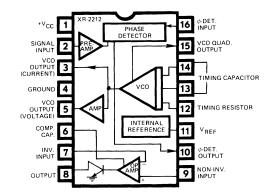
Part Number	Package	Operating Temperature
XR-2211M	Ceramic	-55°C to +125°C
XR-2211N	Ceramic	-40° C to $+85^{\circ}$ C
XR-2211P	Plastic	-40° C to $+85^{\circ}$ C
XR-2211CN	Ceramic	0° C to $+75^{\circ}$ C
XR-2211CP	Plastic	0°C to +75°C

XR-2212 PRECISION PHASE-LOCKED LOOP

The XR-2212 is an ultra-stable monolithic phase-locked loop (PLL) system especially designed for data communication and control system applications. It offers 20 ppm/°C temperature stability and is ideally suited for frequency synthesis, FM detection, and tracking filter applications.

The XR-2212 precision PLL is directly compatible with MOS, DTL, and TTL logic families and microprocessor peripheral systems. The circuit consists of a PLL system made up of an input preamplifier, a phase detector, a stable voltage-controlled oscillator (VCO), and a high-gain differential amplifier. The center frequency, bandwidth, and the tracking range of the PLL are controlled independently by the choice of external components.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Quadrature VCO OutputsWide Frequency Range0.01 Hz to 300 kHzWide Supply Voltage Range4.5V to 20VMOS/TTL/ECL Logic Compatibility4.5V to 20VWide Dynamic Range4.5V to 20VAdjustable Tracking Range (±1% to ±80%)20 ppm/°C, Typical

APPLICATIONS

Frequency Synthesis Data Synchronization FM Detection Tracking Filters

ORDER INFORMATION

Part Number	Package	Operating Temperature
XR-2212M	Ceramic	-55°C to +125°C
XR-2212N	Ceramic	-40° C to $+85^{\circ}$ C
XR-2212P	Plastic	-40° C to $+85^{\circ}$ C
XR-2212CN	Ceramic	0°C to +75°C
XR-2212CP	Plastic	0° C to $+75^{\circ}$ C

FSK Demodulation

Signal Conditioning

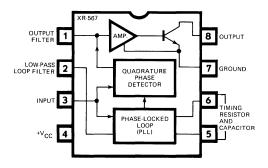
Clock Extraction

Tone Decoders

XR-567 MONOLITHIC TONE DECODER

The XR-567 is a monolithic phase-locked loop system designed for general purpose tone and frequency decoding. It offers a wide frequency band of 0.01 Hz to 500 kHz and has a logic compatible output capable of sinking up to 100 mA of load current. Four independent external components determine the bandwidth, center frequency, and output delay.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct replacement for SE/NE567

Bandwidth Adjustable from 0 to 14%

Logic Compatible Output with 100 mA Current Sinking Capability

Center Frequency Adjustable from 0.01 Hz to 500 kHz Inherent Immunity to False Signals

High Rejection of Out-of-Band Signals and Noise

Frequency Range Adjustable over 20:1 Range by External Resistor

APPLICATIONS

Touch-Tone® Decoding Sequential Tone Decoding Communications Paging Ultrasonic Remote-Control and Monitoring Carrier-Tone Transceiver Wireless Intercom Precision Oscillator

ORDER INFORMATION

Part NumberPackageXR-567MCeramicXR-567CNCeramicXR-567CPPlastic

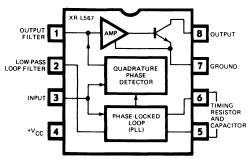
Operating Temperature

amic	-55°C to +125°C
amic	0° C to $+75^{\circ}$ C
tic	0° C to +75 $^{\circ}$ C

XR-L567 MONOLITHIC TONE DECODER

The XR-L567 is a micropower phase-locked loop (PLL) circuit designed for general purpose tone and frequency decoding. It is a direct replacement for the popular 567-type tone decoder IC's in applications requiring very low power dissipation. The XR-L567 offers approximately 1/10th the power dissipation of the conventional 567-type tone decoder, without sacrificing its key features such as the oscillator stability, frequency selectivity and detection threshold. At 5 volt operation, typical quiescent power dissipation is less than 4 mW.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Very Low Power Dissipation (≈4 mW at 5V). Bandwidth Adjustable from 0 to 14%. Logic Compatible Output with 10 mA Current Sinking Capability. Highly Stable Center Frequency. Center Frequency Adjustable from 0.01 Hz to 50 kHz. Inherent Immunity to False Signals. High Rejection of Out-of-Band Signals and Noise. Frequency Range Adjustable Over 20:1 Range by External Resistor.

APPLICATIONS

Battery-Operated Tone Detection Touch-Tone® Decoding Sequential Tone Decoding Communications Paging Ultrasonic Remote-Control Telemetry Decoding

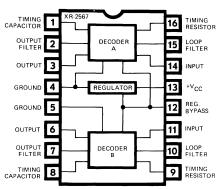
Part Number	Package	Operating Temperature
XR-L567CN	Ceramic	0°C to +75°C
XR-L567CP	Plastic	0°C to +75°C

XR-2567 DUAL MONOLITHIC TONE DECODER

The XR-2567 is a dual monolithic tone decoder wellsuited for tone or frequency decoding in a multiple-tone communication system. Each decoder can be used independently or both sections can be interconnected for dual operation. The matching and temperature tracking characteristics between decoders on this one chip are superior to those available from two separate tone decoder packages.

The XR-2567 operates over a frequency range of 0.01 Hz to 500 kHz with supply voltages from 4.5V to 12V and internal voltage regulation is provided for supplies between 7V and 12V.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Replaces Two 567-Type Decoders Excellent Temperature Tracking Between Decoders Bandwidth Adjustable from 0 to 14% Logic Compatible Outputs with 100 mA Sink Capability Center Frequency Matching (1%, Typical) Center Frequency Adjustable from 0.01 Hz to 500 kHz Inherent Immunity to False Triggering

APPLICATIONS

Touch-Tone® Decoding Sequential Tone Decoding Dual-Tone Decoding/Encoding Communications Paging Ultrasonic Remote-Control and Monitoring Full-Duplex Carrier-Tone Transceiver Wireless Intercom Dual Precision Oscillator FSK Generation and Detection

ORDER INFORMATION

Part Number	Package
XR-2567M	Ceramic
XR-2567CN	Ceramic

Plastic

XR-2567CP

Operating Temperature

-55°C to +125°C 0°C to +75°C 0°C to +75°C

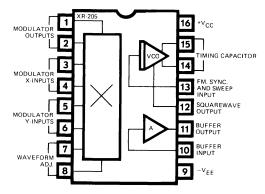
Function Generators

XR-205 MONOLITHIC WAVEFORM GENERATOR

The XR-205 is a highly versatile, monolithic waveform generator designed for diverse applications in communication and telemetry equipment, as well as in systems design and testing. It is a self-contained, totally monolithic signal generator that provides sine, square, triangle, ramp, and sawtooth output waveforms, which can be both amplitude and frequency modulated.

The circuit has three separate sections: a VCO, a balanced modulator, and a buffer amplifier.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

High Frequency Capability (to 4 MHz) Wide Supply Range (+8V to +26V) Output Current Swing of ±10 mA Frequency Sweep Range of 10:1, Typical Low Sinewave Distortion (THD 2.5%, Typical)

APPLICATIONS

Waveform Generation Sinewave Sawtooth Triangle Ramp Square Pulse AM Generation FM Generation Sweep Generation Tone Burst Generation Simultaneous AM/FM FSK Signal Generation On-Off Keyed Oscillation Clock Generation

Part Number	Package	Operating Temperature
XR-205CN	Ceramic	0° C to $+75^{\circ}$ C

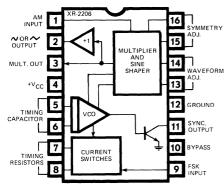
Function Generators

XR-2206 MONOLITHIC FUNCTION GENERATOR

The XR-2206 is a monolithic function generator integrated circuit capable of producing high quality sine, square, triangle, ramp, and pulse waveforms of high stability and accuracy. The output waveforms can be both amplitude and frequency modulated by an external voltage. Frequency of operation can be selected externally over a range of 0.01 Hz to more than 1 MHz.

This circuit is ideally suited for communications, instrumentation, and function generator applications requiring sinusoidal tone, AM, FM, or FSK generation. It has a typical drift specification of 20 ppm/ $^{\circ}$ C.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Low Sinewave Distortion (THD .5%) Insensitive to Signal Sweep Excellent Stability (20 ppm/°C, Typical) Wide Sweep Range (2000:1, Typical) Low Supply Sensitivity (0.01%/V, Typical) Linear Amplitude Modulation Adjustable Duty-Cycle (1% to 99%) TTL Compatible FSK Controls Wide Supply Range (10V to 26V)

APPLICATIONS

Waveform Generation Sine, Square, Triangle, Ramp Sweep Generation AM/FM Generation FSK and PSK Generation Voltage-to-Frequency Conversion Tone Generation Phase-Locked Loops

Operating Temperature -55° C to $+125^{\circ}$ C 0° C to $+75^{\circ}$ C

ORDER INFORMATION

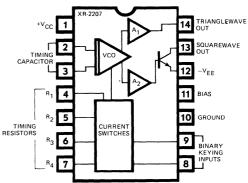
Part Number	Package
XR-2206M	Ceramic
XR-2206N	Ceramic
XR-2206P	Plastic
XR-2206CN	Ceramic
XR-2206CP	Plastic

XR-2207 VOLTAGE-CONTROLLED OSCILLATOR

The XR-2207 is a monolithic voltage-controlled oscillator (VCO) integrated circuit featuring excellent frequency stability and a wide tuning range. The circuit provides simultaneous triangle and squarewave outputs over a frequency range of 0.01 Hz to 1 MHz. It is ideally suited for FM, FSK, sweep or tone generation, and phase-locked loop applications.

The XR-2207 has a typical drift specification of 20 ppm/°C. The oscillator frequency can be linearly swept over a 1000:1 range with an external control voltage.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Excellent Temperature Stability (20 ppm/°C) Linear Frequency Sweep Adjustable Duty Cycle (0.1% to 99.9%) Two or Four Level FSK Capability Wide Sweep Range (1000:1 Minimum) Logic Compatible Input and Output Levels Wide Supply Voltage Range (±4V to ±13V) Low Power Sensitivity (0.15%/V) Wide Frequency Range (0.01 Hz to 1 MHz) Simultaneous Triangle and Squarewave Outputs

APPLICATIONS

FSK Generation Voltage and Current-to-Frequency Conversion Stable Phase-Locked Loop Waveform Generation Triangle, Sawtooth, Pulse, Squarewave FM and Sweep Generation

Part Number	Package	Operating Temperature
XR-2207M	Ceramic	-55°C to +125°C
XR-2207N	Ceramic	0° C to +75 $^{\circ}$ C
XR-2207P	Plastic	0° C to +75 $^{\circ}$ C
XR-2207CN	Ceramic	$0^{\circ}C$ to $+75^{\circ}C$
XR-2207CP	Plastic	0°C to +75°C

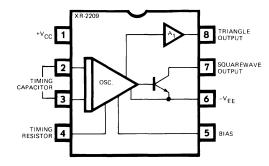
Function Generators

XR-2209 PRECISION **OSCILLATOR**

The XR-2209 is a monolithic variable frequency oscillator circuit featuring excellent temperature stability and a wide linear sweep range. The circuit provides simultaneous triangle and squarewave outputs over a frequency range of 0.01 Hz to 1 MHz. The frequency is set by an external RC product. It is ideally suited for frequency modulation, voltage-to-frequency or current-to-frequency conversion, sweep or tone generation, as well as for phase-locked loop applications when used in conjunction with a phase comparator such as the XR-2208.

The circuit is comprised of three functional blocks: a variable frequency oscillator, and two buffer amplifiers. The XR-2209 has a typical drift specification of 20 ppm/°C. Its frequency can be linearly swept over a 1000:1 range with an external control signal.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Excellent Temperature Stability (20 ppm/ $^{\circ}$ C) Linear Frequency Sweep Wide Sweep Range (1000:1 Minimum) Wide Supply Voltage Range ($\pm 4V$ to $\pm 13V$) Low Supply Sensitivity (0.15%/V)Wide Frequency Range (0.01 Hz to 1 MHz) Simultaneous Triangle and Squarewave Outputs

APPLICATIONS

Voltage and Current-to-Frequency Conversion Stable Phase-Locked Loop Oscillator Waveform Generation FM and Sweep Generation

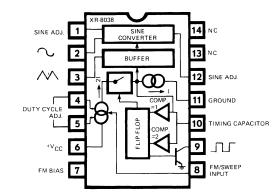
ORDER INFORMATION

Part Number	Package	Operating Temperature
XR-2209M	Ceramic	-55°C to +125°C
XR-2209CN	Ceramic	0°C to +75°C
XR-2209CP	Plastic	0°C to +75°C

XR-8038 PRECISION WAVEFORM GENERATOR

The XR-8038 is a precision waveform generator IC capable of producing sine, square, triangular, sawtooth, and pulse waveforms with a minimum of external components and adjustments. Its operating frequency can be selected over nine decades of frequency, from 0.001 Hz to 1 MHz by the choice of external RC components. The frequency of oscillation is highly stable over a wide temperature and supply voltage range. The frequency modulation and sweeping can be accomplished with an external control voltage without affecting the quality of the output waveforms; and the frequency can be programmed digitally through the use of either resistors or capacitors.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Replacement for Intersil I8038 Low Frequency Drift: 50 ppm/°C Simultaneous Sine-, Triangle- and Square-Wave Outputs Low Distortion: THD 1% High FM and Triangle Linearity Wide Frequency Range: 0.001 Hz to 1 MHz Minimum External Component Count Variable Duty-Cycle: 2% to 98%

APPLICATIONS

Precision Waveform Generation Sweep and FM Generation Sine, Square, Triangle, Pulse Test Instrumentation Design Phase-Locked Clock Generation

Tone Generation Precision PLL Design

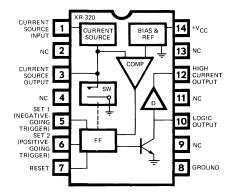
Part Number	Package	Operating Temperature
XR-8038M	Ceramic	-55° C to $+125^{\circ}$ C
XR-8038N	Ceramic	0° C to $+70^{\circ}$ C
XR-8038P	Plastic	0° C to $+70^{\circ}$ C
XR-8038CN	Ceramic	0° C to $+70^{\circ}$ C
XR-8038CP	Plastic	0° C to $+70^{\circ}$ C

XR-320 MONOLITHIC TIMING CIRCUIT

The XR-320 monolithic timing circuit is designed for use in instrumentation and digital communications equipment, industrial control, and special testing applications. In many cases, this circuit provides a monolithic replacement for mechanical or electro-mechanical timing devices.

The XR-320 features a precision current source, a voltage comparator, a flip-flop, a timing switch, and a pair of output logic drivers. When triggered, it produces a highlylinear positive-going ramp voltage across the external timing capacitor for a duration of 2.0 RC. The high current output at pin 12 can sink or source up to 100 mA of current. The XR-320 is specified over the commercial temperature range of 0° C to $+75^{\circ}$ C.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Wide Timing Range: 1µsec to 1 Hour Positive- and Negative-Going Outputs Excellent Temperature Stability: 100 ppm/°C Wide Supply Voltage Range: 4.5V to 18V Triggering with Positive- or Negative-Going Pulses **Programmable Timing**

3 Decades of Resistor Programming 9 Decades of Capacitor Programming Logic Compatible Outputs High Current Drive Capability: 100 mA

APPLICATIONS

Precision Timing Time-Delay Generation Sequential Timing Pulse Generation/Shaping

Pulse-Position Modulation Pulse-Width Modulation Sweep Generation

ORDER INFORMATION

Part Number Package XR-320P Plastic

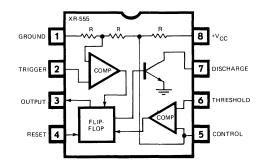
Operating Temperature 0° C to $+70^{\circ}$ C

XR-555 TIMING CIRCUIT

The XR-555 monolithic timing circuit is a highly stable controller capable of producing accurate timing pulses. It is a direct, pin-for-pin replacement for the SE/NE 555 timer. The circuit contains independent control terminals for triggering or resetting, if desired.

The mode of operation can be either monostable or astable. The XR-555 may be triggered or reset on falling waveforms and its output can source or sink up to 200 mA or drive TTL circuits.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Replacement for SE/NE 555 Timing from Microseconds through Hours Operates in Both Monostable and Astable Modes High Current Drive Capability (200 mA) TTL and DTL Compatible Outputs Adjustable Duty Cycle Temperature Stability of .005%/°C

Package

Ceramic

Ceramic

Plastic

APPLICATIONS

Precision Timing Pulse Generation Sequential Timing Pulse Shaping **Clock Generation**

Missing-Pulse Detection Pulse-Width Modulation Frequency Division **Appliance** Timing

ORDER INFORMATION

Part Number	
XR-555M	
XR-555CN	
XR-555CP	

Pulse-Position Modulation

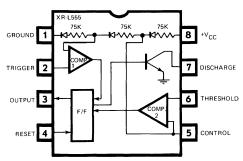
Operating Temperature

-55° C to $+125^{\circ}$ C
0° C to $+75^{\circ}$ C
0°C to +75°C

XR-L555 MICROPOWER TIMING CIRCUIT

The XR-L555 is a stable micropower controller capable of producing accurate timing pulses with low power dissipation. Typical power dissipation is 900 microwatts at 5V. The circuit offers both the monostable or the astable modes of operation and can operate with power supplies as low as 2.7 volts. It may be triggered or reset on falling waveforms. The output can source up to 50 mA or drive TTL circuits. The XR-L555 features temperature stability and low-voltage operation, ideal as a micropower clock oscillator or VCO for low-power CMOS systems. It can operate up to 1500 hours with only two 300 mA-Hr NiCd batteries.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Pin Compatible with Standard 555 Timer Less than 1 mW Power Dissipation (V+ = 5V) Timing from Microseconds to Minutes Over 1000-Hour Operation with 2 NiCd Batteries Low Voltage Operation (V+ = 2.7V) Operates in Both Monostable and Astable Modes CMOS, TTL, and DTL Compatible Outputs Adjustable Duty Cycle Temperature Stability of .005%/°C

APPLICATIONS

Battery Operated Timing Micropower Clock Generator Pulse Shaping and Detection Micropower PLL Design Missing Pulse Detection Power-On Reset Controller Micropower Oscillator Sequential Timing Pulse-Width Modulation Pulse Position Modulation Appliance Timing Remote-Control Sequencer

ORDER INFORMATION

Part Number	Package
XR-L555M	Ceramic
XR-L555CN	Ceramic
XR-L555CP	Plastic

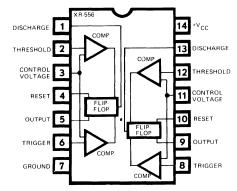
Operating Temperature

-55°C to +125°C 0°C to +75°C 0°C to +75°C

XR-556 DUAL TIMER

The XR-556 dual timing circuit contains two independent type timers on a single monolithic chip. It is a direct pinfor-pin replacement for the SE/NE 556 dual timer. Each timer section is a highly stable controller capable of producing accurate time delays or oscillations, and each has independent outputs and control terminals. The circuit can be used for monostable or astable operation. The XR-556 may be triggered or reset on falling waveforms and each output can source up to 150 mA or drive TTL circuits. Each timer section features excellent matching and temperature tracking characteristics.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Replacement for SE/NE 556 Replaces Two 555-Type Timers TTL Compatible Pinouts for +V_{CC} and Ground Timing from Microseconds Through Hours Excellent Matching Between Timer Sections Operates in Both Monostable and Astable Modes High Current Drive Capability (150 mA each output) TTL and DTL Compatible Outputs Adjustable Duty Cycle Temperature Stability of 0.005%/°C

APPLICATIONS

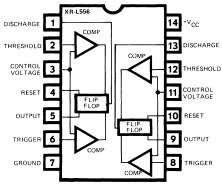
Precision Timing	Missing-Pulse Detection
Pulse Generation	Pulse-Width Modulation
Sequential Timing	Frequency Division
Pulse Shaping	Clock Synchronization
Time Delay Generation	Pulse-Position Modulation
Clock Pattern Generation	Appliance Timing

Part Number	Package	Operating Temperature
XR-556M	Ceramic	-55° C to $+125^{\circ}$ C
XR-556CN	Ceramic	0° C to +75 $^{\circ}$ C
XR-556CP	Plastic	0° C to +75 $^{\circ}$ C

XR-L556 DUAL Micropower Timer

The XR-L556 is the dual-version of the XR-L555 micropower timer. It contains two low-power timer circuits on a single IC chip. Each timer section has completely independent control terminals, and independent outputs. The typical stand-by power dissipation for the entire circuit (i.e. both timer sections) is less than 2 mW at 5V. The circuit offers both the monostable or the astable modes of operation and can operate with power supplies as low as 2.7 volts. It may be triggered or reset on falling waveforms. Each of the outputs can source up to 50 mA or drive TTL circuits. Each timer section features excellent matching and temperature tracking characteristics.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Micropower Equivalent of 556-Type Dual Timer Less than 2 mW Power Dissipation (V+ = 5V) Timing from Microseconds to Minutes Over 500-Hour Operation with 2 NiCd Batteries Low Voltage Operation (V+ = 2.7V) Operates in Both Monostable and Astable Modes CMOS, TTL, and DTL Compatible Outputs Adjustable Duty Cycle Temperature Stability of .005%/°C

APPLICATIONS

Battery Operated Timing Micropower Clock Generator Pulse Shaping and Detection Micropower PLL Design Missing Pulse Detection Power-On Reset Controller Micropower Oscillator Sequential Timing Pulse-Width Modulation Pulse Position Modulation Appliance Timing Remote-Control Sequencer

ORDER INFORMATION

Operating Temperature

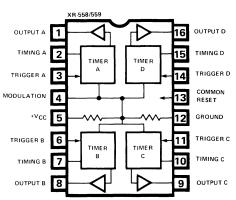
XR-L556M	Ceramic	-55°C to +125°C
XR-L556CN	Ceramic	0° C to $+75^{\circ}$ C
XR-L556CP	Plastic	0°C to +75°C

Package

XR-558/XR-559 QUAD TIMER CIRCUITS

The XR-558 and the XR-559 are quad-timer circuits which contain four separate timers in a single IC package. These four timer sections share a common reset control; however each section has its own independent trigger, timing and output terminals. The XR-558 quad timer has four independent outputs each of which can *source* up to 100 mA of current. The XR-559 has four independent outputs which can *sink* up to 100 mA per output. All of the four timing sections are edge-triggered, and they can be cascaded without requiring coupling capacitors.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Replacement for NE558/NE559 100 mA Output Current per Section Edge-Triggered Inputs Produces Four Independent Time Delays Wide Supply Range: 4.5V to 15V Timing Interval from Microseconds to Minutes Time Interval Equal to 1.0 RC

APPLICATIONS

Sequential Timing Time Delay Generation Precision Timing Industrial Controls Quad One-Shot

ORDER INFORMATION

Part Number	Package	Operating Temperature
XR-558M	Ceramic	-55° C to $+125^{\circ}$ C
XR-558CN	Ceramic	0°C to +70°C
XR-558CP	Plastic	0°C to +70°C
XR-559M	Ceramic	-55°C to +125°C
XR-559CN	Ceramic	0°C to +70°C
XR-559CP	Plastic	0°C to +70°C

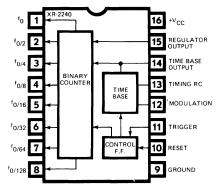
Part Number

XR-2240 PROGRAMMABLE TIMER/COUNTER

The XR-2240 Programmable Timer/Counter is a monolithic controller capable of producing ultra-long time delays, from microseconds up to five days, without sacrificing accuracy. Two timing circuits can be cascaded to generate time delays up to three years. The circuit is comprised of an internal time-base oscillator, a programmable 8-bit counter, and a control flip-flop. The time delay is set by an external RC network and can be programmed to any value from 1 RC to 255 RC.

In most timing applications, one or more of the counter outputs are connected back to the reset terminal. The circuit will then start timing when a trigger is applied and will automatically reset itself to complete the timing cycle when a programmed count is completed. If none of the counter outputs are connected back to the reset terminal, the circuit will operate in its astable or free-running mode, subsequent to a trigger input.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Timing from Microseconds to Days Programmable Delays: 1 RC to 255 RC Wide Supply Range: 4V to 15V TTL and DTL Compatible Outputs High Accuracy: 0.5% External Sync and Modulation Capability Excellent Supply Rejection: 0.2%/V

APPLICATIONS

Precision TimingFrequency SynthesisLong Delay GenerationPulse Counting/SummingSequential TimingA/D ConversionBinary Pattern GenerationDigital Sample and Hold

ORDER INFORMATION

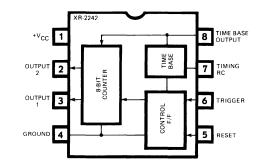
Part Number	Package	Operating Temperature
XR-2240M	Ceramic	-55°C to +125°C
XR-2240N	Ceramic	0° C to +75 $^{\circ}$ C
XR-2240P	Plastic	$0^{\circ}C$ to $+75^{\circ}C$
XR-2240CN	Ceramic	$0^{\circ}C$ to $+75^{\circ}C$
XR-2240CP	Plastic	0° C to $+75^{\circ}$ C

XR-2242 LONG-RANGE TIMER

The XR-2242 is a monolithic Timer/Controller capable of producing ultra-long time delays from microseconds to days. Two timing circuits can be cascaded to generate time delays or timing intervals of up to one year. The circuit is comprised of an internal time-base oscillator, an 8-bit binary counter and a control flip-flop. For a given external RC network connected to the timing terminal, the circuit produces an output timing pulse of 128 RC. If two circuits are cascaded, a total time delay of $(128)^2$ or 16,384 RC is obtained.

In monostable timer applications, the output terminal (pin 3) is connected back to the reset terminal, the circuit continues to operate in an astable mode, subsequent to a trigger input.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Timing from Microseconds to Days Wide Supply Range: 4.5V to 15V TTL and DTL Compatible Outputs High Accuracy: 0.5% Excellent Supply Rejection: 0.2%/V Monostable and Astable Operation

APPLICATIONS

Long Delay Generation Sequential Timing Precision Timing Ultra-Low Frequency Oscillator Interval Timing

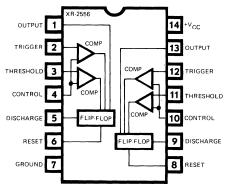
Part Number	Package	Operating Temperature
XR-2242M	Ceramic	-55° C to $+125^{\circ}$ C
XR-2242CN	Ceramic	0° C to $+75^{\circ}$ C
XR-2242CP	Plastic	0° C to $+75^{\circ}$ C

XR-2556 DUAL TIMING CIRCUIT

The XR-2556 dual timing circuit contains two independent 555-type timers on a single monolithic chip. Each timer section is a highly stable controller capable of producing accurate time delays or oscillations. Each timer has independent output and control terminals and can be used for monostable or astable operation.

The XR-2556 may be triggered or reset on falling waveforms, and each output can source or sink up to 200 mA of load current, or drive DTL and TTL circuits. The matching and temperature tracking characteristics of the two timer sections of the XR-2556 are superior to those available from timers in separate packages.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Replaces Two 555-Type Timers TTL Compatible Pinouts (Gnd – Pin 7, V_{CC} – Pin 14) Timing from Microseconds Through Hours Excellent Matching Between Timer Sections Operates in Both Monostable and Astable Modes High Current Drive Capability (200 mA each output) TTL and DTL Compatible Outputs Adjustable Duty Cycle Temperature Stability of 0.005%/°C

APPLICATIONS

Precision Timing Pulse Generation Sequential Timing Pulse Shaping Time Delay Generation

Missing-Pulse Detection Pulse-Width Modulation Frequency Division Clock Synchronization Pulse-Position Modulation

ORDER INFORMATION

Part Number	Package
XR-2556M	Ceramic
XR-2556CN	Ceramic
XR-2556CP	Plastic

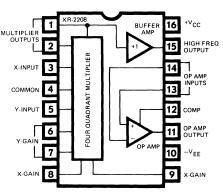
Operating Temperature
-55° C to $+125^{\circ}$ C

 $0^{\circ}C$ to +75°C $0^{\circ}C$ to +75°C

Multipliers and Modulators

XR-2208 OPERATIONAL MULTIPLIER

The XR-2208 operational multiplier combines a fourquadrant analog multiplier (or modulator), a high-frequency buffer amplifier and an operational amplifier in a monolithic circuit that is ideally suited for both analog computation and communications signal processing applications. The multiplier/buffer amplifier combination extends the small signal 3 dB bandwidth to 8 MHz and the transconductance bandwidth to 100 MHz.



FEATURES

Maximum Versatility Independent Multiplier, Op Amp and Buffer Excellent Linearity (0.3%, typical) Wide Bandwidth 3 dB Bandwidth – 8 MHz typical 3° Phase Shift Bandwidth – 1.2 MHz typical Transconductance Bandwidth – 100 MHz typical Simplified Offset Adjsutments Wide Supply Voltage Range (±4.5V to ±16V)

APPLICATIONS

Analog Computation
Multiplication
DivisionTriangle-to-Sinewave Converter
AGC Amplifier
Phase DetectorSignal Processing
AM Generation
Frequency Doubling
Frequency Translation
Synchronous AM DetectionMit and the second se

Ceramic

Ceramic

Ceramic

Plastic

Plastic

ORDER INFORMATION

Part Number XR-2208M XR-2208N XR-2208P XR-2208CN XR-2208CP ng tion Detection IATION Package Operating Temperature

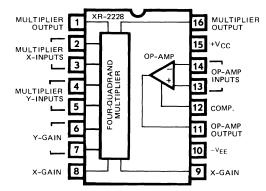
55°0 + 125°0
-55° C to $+125^{\circ}$ C
0° C to +75 $^{\circ}$ C
0° C to $+75^{\circ}$ C
0° C to $+75^{\circ}$ C
0° C to +75 $^{\circ}$ C

Multipliers and Modulators

XR-2228 MULTIPLIER/ DETECTOR

The XR-2228 multiplier/detector circuit is designed as a basic building block for analog signal processing and communication systems. It contains a four-quadrant analog multiplier/modulator and a high-gain op-amp on the same chip. Because of its wide common-mode range and differential inputs, the XR-2228 can interface with any of the existing PLL circuits in designing synchronous AM detection or frequency translation systems. It can be used as a phase-detector for frequencies up to 100 MHz.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Independent Multiplier and Op Amp Differential X and Y Inputs Interfaces with all PLL and VCO Circuits Wide Common Mode Range Wide Transconductance Bandwidth (100 MHz, Typ.)

APPLICATIONS

Phase-Locked Loop Design Phase Detection Synchronous AM Detection AM Generation Triangle-to-Sinewave Conversion Frequency Translation

ORDER INFORMATION

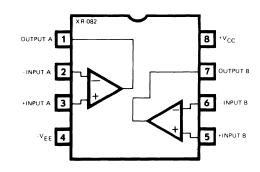
Part Number	Package	Operating Temperature
XR-2228M	Ceramic	-55°C to +125°C
XR-2228N	Ceramic	-40° C to $+85^{\circ}$ C
XR-2228P	Plastic	-40° C to $+85^{\circ}$ C
XR-2228CN	Ceramic	-40° C to $+85^{\circ}$ C
XR-2228CP	Plastic	0°C to +75°C

Operational Amplifiers

XR-082 DUAL BIFET OPERATIONAL AMPLIFIER

The XR-082 family of junction-FET input (BIFET) dual operational amplifiers are designed to offer high performance and a wider selection than conventional bipolar op amps. Each amplifier features high slew rate, low input bias and offset currents, and low offset voltage drift with temperature.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Replacement for Texas Instruments TL082 Low Harmonic Distortion (0.01% Typ.) Same Pin Configuration as XR-1458/XR-4558 Low Power Consumption Low Input Bias and Offset Currents Output Short-Circuit Protection High Input Impedance ... FET-Input Stage Internal Frequency Compensation Latch-Up-Free Operation High Slew-Rate ... 13 V/µs, Typ.

APPLICATIONS

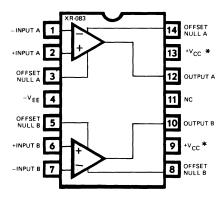
Low-Level Signal Detection Active Filter Design Signal Conditioning Analog Amplification Audio Signal Processing Analog Sample-and-Hold

Part Number	Package	Operating Temperature
XR-082M	Ceramic	-55° C to $+125^{\circ}$ C
XR-082N	Ceramic	-25° C to $+85^{\circ}$ C
XR-082P	Plastic	-25° C to $+85^{\circ}$ C
XR-082CN	Ceramic	0° C to $+75^{\circ}$ C
XR-082CP	Plastic	0°C to +75°C

XR-083 DUAL BIFET OPERATIONAL AMPLIFIER

The XR-083 junction-FET input dual operational amplifier contains two independent op amp sections on the same chip. Each op amp section offers independent offset-null terminals. Except for the offset adjustment capability, the electrical characteristics of both op amp sections are similar to those of the XR-082 Bifet op amp family.

FUNCTIONAL BLOCK DIAGRAM



Note: Pins 9 and 13 are intenally connected.

FEATURES

Direct Replacement for Texas Instrument TL083 Low Power Consumption Wide Common-Mode and Differential Voltage Ranges Low Input Bias and Offset Currents Output Short-Circuit Protection High Input Impedance: FET Input Stage Internal Frequency Compensation Latch-Up Free Operation High Slew Rate: 13V/µs, Typical Independent Offset-Trim Adjustments

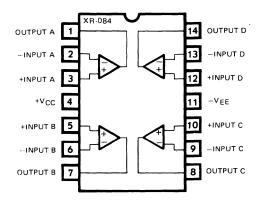
ORDER INFORMATION

Part Number	Package	Operating Temperature
XR-083M	Ceramic	-55°C to +125°C
XR-083N	Ceramic	-25°C to +85°C
XR-083P	Plastic	-25°C to +85°C
XR-083CN	Ceramic	0°C to +75°C
XR-083CP	Plastic	0° C to $+75^{\circ}$ C

XR-084 QUAD BIFET OPERATIONAL AMPLIFIER

The XR-084 junction-FET input (BIFET) quad operational amplifier is designed to offer higher performance than conventional bipolar quad op amps. Each of the four op amps on the chip is closely matched in performance characteristics, and each amplifier features high slew rate, low input bias and offset currents, and low offset voltage drift with temperature. The XR-084 FET input quad op amp is fabricated using ion-implantation technology which combines well-matched junction FETs and high-performance bipolar transistors on the same monolithic integrated circuit.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Replacement for Texas Instrument TL084 Same Pin Configuration as XR-3403, LM324 High-Impedance Junction-FET Input Stage Internal Frequency Compensation Low Power Consumption Wide Common-Mode and Differential Voltage Ranges Low Input Bias and Offset Currents Output Short-Circuit Protection Latch-Up Free Operation High Slew Rate: $13V/\mu$ s, Typical

APPLICATIONS

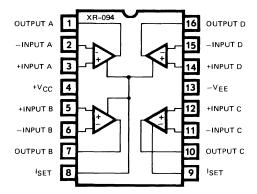
Active Filter Design Sample/Hold and Servo Systems Audio Signal Processing Analog Control Systems

Part Number	Package	Operating Temperature
XR-084M	Ceramic	-55° C to $+125^{\circ}$ C
XR-084N	Ceramic	-25° C to $+85^{\circ}$ C
XR-084P	Plastic	-25° C to $+85^{\circ}$ C
XR-084CN	Ceramic	0° C to $+75^{\circ}$ C
XR-084CP	Plastic	0° C to $+75^{\circ}$ C

XR-094 QUAD PROGRAMMABLE BIFET OPERATIONAL AMPLIFIER

The XR-094 is a programmable version of the XR-084 family of quad FET-input operational amplifiers. The circuit offers partitioned programming where the three of the four op amps on the chip are programmed by one external bias-setting resistor, and the fourth op amp is programmed by a second bias-setting resistor. These two external setting resistors permit the user to program the gain-bandwidth product, slewrate and the supply current, especially for low power applications. The XR-094 programmable BIFET quad op amp is fabricated using ion-implantation technology which combines well-matched junction FETs and high-performance bipolar transistors on the same monolithic integrated circuit.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Programmable Version of Texas Instruments TL084 Same Pin Configuration as LM146/246/346 Programmable for Micropower Operation Partitioned Programming (Single/Triple Combination) High-Impedance Junction-FET Input Stage Internal Frequency Compensation Low Input Bias and Offset Currents

APPLICATIONS

Active Filter Design	Audio Signal Processing
Sample/Hold and	Analog Control Systems
Servo Systems	Telephone Channel Filters

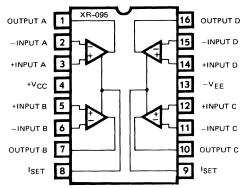
ORDER INFORMATION

Part Number	Package	Operating Temperature
XR-094M	Ceramic	-55° C to $+125^{\circ}$ C
XR-094N	Ceramic	-25° C to $+85^{\circ}$ C
XR-094P	Plastic	-25° C to $+85^{\circ}$ C
XR-094CN	Ceramic	0° C to +75 $^{\circ}$ C
XR-094CP	Plastic	0° C to +75 $^{\circ}$ C

XR-095 QUAD PROGRAMMABLE BIFET OPERATIONAL AMPLIFIER

The XR-095 is a programmable version of the XR-084 family of quad FET-input operational amplifiers. The circuit offers partitioned programming of the individual op amp sections on the chip: two of the op amps are programmed by one bias-setting resistor, and the remaining two op amps are programmed by a separate bias-setting resistor. These two external setting resistors permit the user to program the gainbandwidth product, slew-rate and the supply current, especially for low power applications. The XR-095 programmable BIFET quad op amp is fabricated using ion-implantation technology which combines well-matched junction FETs and high-performance bipolar transistors on the same monolithic integrated circuit.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Programmable Version of Texas Instruments TL084 Same Pin Configuration as LM346-2 Partitioned Programming (Two Dual Combination) Programmable for Micropower Operation High-Impedance Junction-FET Input Stage Internal Frequency Compensation Low Input Bias and Offset Currents

APPLICATIONS

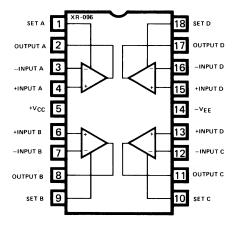
Active Filter Design	Audio Signal Processing
Sample/Hold and	Analog Control Systems
Servo Systems	Telecommunication Systems

Part Number	Package	Operating Temperature
XR-095M	Ceramic	-55° C to $+125^{\circ}$ C
XR-095N	Ceramic	-25° C to $+85^{\circ}$ C
XR-095P	Plastic	-25° C to $+85^{\circ}$ C
XR-095CN	Ceramic	0° C to $+75^{\circ}$ C
XR-095CP	Plastic	0° C to $+75^{\circ}$ C

XR-096 QUAD PROGRAMMABLE BIFET OPERATIONAL AMPLIFIER

The XR-096 is the independently-programmable version of the XR-084 family of quad FET-input operational amplifiers. The circuit offers *fully independent* programming of each of the four separate op amps on the chip, by means of four external bias setting resistors. These external setting resistors allow the user to program the gain-bandwidth product, slew-rate and the supply-current for each of the four op amps independently, or permit the unused op amps to be shut-off or powered down.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Programmable Version of XR-084 Independent Programming of All Four Op Amps Programmable for Micropower Operation High-Impedance Junction-FET Input Stage Internal Frequency Compensation Low Input Bias and Offset Currents

APPLICATIONS

Active Filter Design Sample/Hold and Servo Systems Analog Multiplexers Audio Signal Processing Analog Control Systems Telecommunication Systems

ORDER INFORMATION

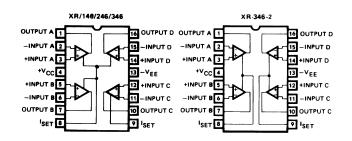
Part Number	Package	Operating Temperature
XR-096M	Ceramic	-55°C to +125°C
XR-096N	Ceramic	-25°C to +85°C
XR-096P	Plastic	-25°C to +85°C
XR-096CN	Ceramic	0°C to +75°C
XR-096CP	Plastic	0°C to +75°C

XR-146/246/346 PROGRAMMABLE QUAD OPERATIONAL AMPLIFIER

The XR-146 family of quad operational amplifiers contain four independent high-gain, low-power, programmable op amps on a monolithic chip. The use of external bias setting resistors permit the user to program gain-bandwidth product, supply current, input bias current, input offset current, input noise and the slew rate.

The basic XR-146 family of circuits offer partitioned programming of the internal op-amps where one setting resistor is used to set the bias levels in the three op amps, and a second bias setting is used for the remaining op amp. Its modified version, the XR-346-2 provides a separate bias setting resistor for each of the two op amp pairs.

FUNCTIONAL BLOCK DIAGRAMS



FEATURES

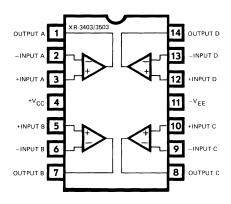
Direct Replacement for LM146/246/346 (XR-146 Family) Direct Replacement for LM346-2 (XR-346-2) Programmable Electrical Characteristics Low Supply Current (350 μ A per Amplifier) Large DC Voltage Gain (120 dB) Low Noise Voltage (25 nV/ \sqrt{Hz}) Wide Power Supply Range (±1.5V to ±22V) Class AB Output Stage—No Crossover Distortion

Part Number	Package	Operating Temperature
XR-146M XR-246N XR-246P XR-346CN XR-346CP XR-346-2CN XR-346-2CP	Ceramic Ceramic Plastic Ceramic Plastic Ceramic Plastic	$\begin{array}{c} -55^{\circ}\text{C to} +125^{\circ}\text{C} \\ -25^{\circ}\text{C to} +85^{\circ}\text{C} \\ -25^{\circ}\text{C to} +75^{\circ}\text{C} \\ 0^{\circ}\text{C to} +75^{\circ}\text{C} \end{array}$

XR-3403/3503 QUAD OPERATIONAL AMPLIFIER

The XR-3403 is an array of four independent operational amplifiers, each with true differential inputs. The device has electrical characteristics similar to the popular 741. However, the XR-3403 has several distinct advantages over standard operational amplifier types in single supply applications. The XR-3403 can operate at supply voltages as low as 3.0 volts or as high as 36 volts with quiescent currents about one-fifth of those associated with the 741 (on a per amplifier basis). The common mode input range includes the negative supply, thereby eliminating the necessity for external biasing components in many applications. The output voltage swing extends to the negative supply.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Pin-for-Pin Replacement for MC3403/3503, LM324, and RC4137 Suitable for Single-Supply Operation Short Circuit Protected Outputs Class AB Output Stage (No Crossover Distortion) Single Supply Operation: 3.0 to 36 Volts Split Supply Operation: ±1.5 to ±18 Volts Low Input Bias Currents: 500 nA Maximum Four Amplifiers per Package Internally Compensated

ORDER INFORMATION

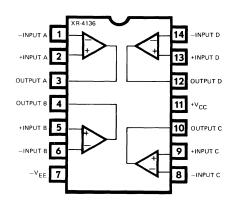
Part Number	Package
XR-3503M	Ceramic
XR-3403CN	Ceramic
XR-3403CP	Plastic

Operating Temperature -55° C to $+125^{\circ}$ C 0° C to $+75^{\circ}$ C 0° C to $+75^{\circ}$ C

XR-4136 QUAD OPERATIONAL AMPLIFIER

The XR-4136 is an array of four independent internallycompensated operational amplifiers on a single silicon chip, each similar to the popular 741, but with a power consumption less than one 741. Good thermal tracking and matched gain-bandwidth products make these quad op amps useful for active filter applications.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Pin-for-Pin Replacement for RC4136 and RM4136 Low Power Consumption (50 mW typ and 120 mW max) Short-Circuit Protection Internal Frequency Compensation No Latch-Up Wide Common-Mode and Differential Voltage Ranges Matched Gain-Bandwidth

APPLICATIONS

Active Filter Design Signal Conditioning Analog Amplification Audio Signal Processing

ORDER INFORMATION

Part Number
XR-4136M
XR-4136CN
XR-4136CP

Ceramic Ceramic Plastic

Package

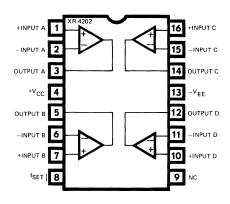
-55°C to +125°C 0°C to +75°C 0°C to +75°C

Operating Temperature

XR-4202 PROGRAMMABLE QUAD OPERATIONAL AMPLIFIER

The XR-4202 is an array of four independent operational amplifiers on a single silicon chip. The operating current of the array is externally controlled by a single setting resistor or current source, allowing the user to trade-off power dissipation for bandwidth for all of the four amplifiers in the package.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Programmable Micropower Operation Wide Input Voltage and Common Mode Range Internal Frequency Compensation No Latch-Up Matched Parameters Short Circuit Protection

APPLICATIONS

Active Filter Design Signal Conditioning Analog Amplification Audio Signal Processing

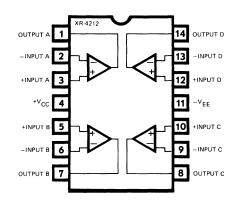
ORDER INFORMATION

Part Number	Package
XR-4202N	Ceramic
XR-4202P	Plastic

XR-4212 QUAD OPERATIONAL AMPLIFIER

The XR-4212 is an array of four independent, internallycompensated operational amplifiers on a single silicon chip, each similar in performance to the popular 741. However, the combined power consumption of all four op amps is less than that of a single, conventional 741-type op amp. Good thermal tracking and matched gain-bandwidth products make these quad op amps useful for active filter applications.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Same Pinout as MC3403, LM324, and HA4741 Low Power Consumption (50 mW typ and 120 mW max) Short-Circuit Protection Internal Frequency Compensation No Latch-Up Wide Common-Mode and Differential Voltage Ranges Matched Gain-Bandwidth

APPLICATIONS

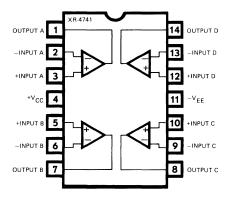
Active Filter Design Signal Conditioning Analog Amplification Audio Signal Processing

Part Number	Package	Operating Temperature
XR-4212M	Ceramic	-55° C to $+125^{\circ}$ C
XR-4212CN	Ceramic	0°C to +75°C
XR-4212CP	Plastic	0°C to +75°C

XR-4741 QUAD OPERATIONAL AMPLIFIER

The XR-4741 is an array of four independent internallycompensated operational amplifiers on a single silicon chip, each similar to the popular 741. Each amplifier offers performance equal to or better than the 741 type in all respects. It has high slew rate, superior bandwidth, and low noise, which makes it excellent for audio amplifiers or active filter applications

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Pin-for-Pin Replacement for HA4741Pin Compatible with MC3403 and LM324High Slew Rate $1.6V/\mu S (Typ)$ Unity Gain-Bandwidth3.5 MHz (Typ)Low Noise Voltage $9 nV/\sqrt{Hz} (Typ)$ Input Offset Current.5 mV (Typ)Wide Supply Range $\pm 2V$ to $\pm 20V$

APPLICATIONS

Active Filter Design Signal Conditioning Analog Amplification Audio Signal Processing

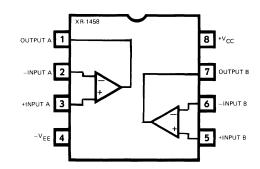
ORDER INFORMATION

Part Number	Package	Operating Temperature
XR-4741M	Ceramic	$-55^{\circ}C$ to $+125^{\circ}C$
XR-4741CN	Ceramic	$0^{\circ}C$ to $+75^{\circ}C$
XR-4741CP	Plastic	0° C to $+75^{\circ}$ C

XR-1458/4558 DUAL OPERATIONAL AMPLIFIER

The XR-1458/4558 is a pair of independent internallycompensated operational amplifiers on a single silicon chip, each similar in performance to the popular 741. However, the power consumption of each of the op amps is less than one-half of the power consumption of a conventional 741. Good thermal tracking and matched gainbandwidth products make these dual op amps useful for active filter applications.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Pin-for-Pin Replacement for MC1458, RC4558, SA1458 Low Power Consumption (50 mW typ and 120 mW max) Short-Circuit Protection Internal Frequency Compensation No Latch-Up Wide Common-Mode and Differential Voltage Ranges Matched Gain-Bandwidth

APPLICATIONS

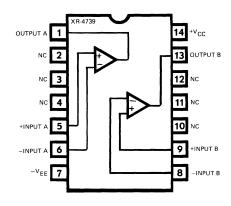
Active Filter Design Signal Conditioning Analog Amplification Audio Signal Processing

Part Number	Package	Operating Temperature
XR-1458CN	Ceramic	0° C to +70 $^{\circ}$ C
XR-1458CP	Plastic	$0^{\circ}C$ to $+70^{\circ}C$
XR-4558CN	Ceramic	0° C to $+70^{\circ}$ C
XR-4558CP	Plastic	0°C to +70°C

XR-4739 DUAL LOW-NOISE OPERATIONAL AMPLIFIER

The XR-4739 dual low-noise operational amplifier is fabricated on a single silicon chip using Exar's low-noise planar epitaxial process. It is designed primarily for preamplifiers in a consumer and industrial signal processing equipment. The device is pin-compatible with the μ A739 and MC1303, with internal compensation added. This permits a reduced external parts count and simplified application.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Pin-for-Pin Replacement for RC4739
Internally Compensated Replacement for μA739 and MC1303
Signal-to-Noise Ratio 76 dB (R1AA 10 mV ref.)
Channel Separation 125 dB
Unity Gain-Bandwidth 3 MHz
Output Short-Circuit Protected
0.1% Distortion at 8.5V RMS Output into 2KΩ Load

APPLICATIONS

High-Quality Audio Preamplification Low-Level Signal Detection Active Filter Design Signal Conditioning Analog Amplification Audio Signal Processing

ORDER INFORMATION

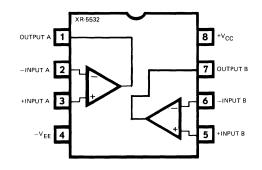
Part Number	Package
XR-4739CN	Ceramic
XR-4739CP	Plastic

Operating Temperature $0^{\circ}C$ to $+75^{\circ}C$ $0^{\circ}C$ to $+75^{\circ}C$

XR-5532 DUAL LOW-NOISE OPERATIONAL AMPLIFIER

The XR-5532 ultra-low noise dual operational amplifier is especially designed for high quality audio and instrumentation applications. Compared to the standard 741- or 301A type op amps, these operational amplifiers show an order of magnitude, better noise performance and small signal bandwidth, higher output drive capability, and they are internally compensated. The XR-5532A is specially screened for a guaranteed ultra-low noise specification.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Pin for Pin Replacement MC1458, RC4558, TL072, TL082, LF353 Direct Replacement for NE5532/NE5532A Ultra-Low Input Noise (4 nV/ $\sqrt{\text{Hz}}$ Typ.) Wide Small-Signal Bandwidth (10 MHz Typ.) High Output Drive Capability (10 V rms into 600 Ω) Wide Supply Range (± 3V to ± 20V) Wide Power Bandwidth (200 kHz) High Slew-Rate: 6V/µsec

APPLICATIONS

Professional Audio Equipment Instrumentation and Servo Control Telephone Channel Amplifier Low-Level Signal Processing Audio Preamplification

ORDER INFORMATION

Part	Number	F	Package

Operating Temperature

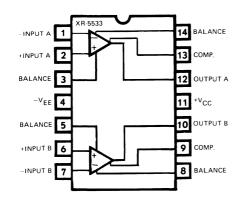
XR-5532ACN Ceramic XR-5532CN Ceramic

0°C to +75°C 0°C to +75°C

XR-5533 DUAL LOW-NOISE OPERATIONAL AMPLIFIER

The XR-5533 ultra-low noise dual operational amplifier is especially designed for high quality audio and instrumentation applications. Compared to the standard 741- or 301A type op amps, these operational amplifiers show an order of magnitude better noise performance, small signal bandwidth and high output drive capability. The XR-5533 is internally compensated for a voltage gain of three or more and offers independent offset adjustments for each of the two op amps. The XR-5533A is specially screened for a guaranteed ultra-low noise specification.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Replacement for NE5533/NE5533A Dual Version of XR-5534 or NE5534 Ultra-Low Input Noise (4 nV/ $\sqrt{\text{Hz}}$ Typ.) Wide Small-Signal Bandwidth (10 MHz Typ.) High Output Drive Capability (10 V rms into 600 Ω) Wide Supply Range (±3V to ±20V) Wide Power Bandwidth (200 kHz) High Slew-Rate: 13 V/ μ sec Independent Offset Adjustments

APPLICATIONS

Professional Audio Equipment Instrumentation and Servo Control Telephone Channel Amplifier Low-Level Signal Processing Audio Preamplification

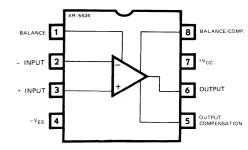
ORDER INFORMATION

Part Number	Package	Operating Temperature
XR-5533ACN	Ceramic	0°C to +75°C
XR-5533CN	Ceramic	0° C to $+75^{\circ}$ C
XR-5533ACP	Plastic	0°C to +75°C
XR-5533CP	Plastic	0°C to +75°C

XR-5534 LOW-NOISE OPERATIONAL AMPLIFIER

The XR-5534 is a high performance, ultra-low noise operational amplifier. Compared to standard 741- or 301-type op amps, it shows an order of magnitude, better noise performance and small signal bandwidth and significantly better output drive capability. The XR-5534 is ideally suited for applications in high quality and professional audio equipment, instrumentation, control circuits and telephone channel amplifiers. The op amp is internally compensated for a gain of three or greater. The frequency response can be optimized with an external compensation capacitor for applications requiring unity-gain, low-overshoot response, or capacitive load driving. The XR-5534A is specially screened for a guaranteed ultra-low noise specification.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Replacement for NE5534/NE5534A Ultra-Low Input Noise (4 nV/ $\sqrt{\text{Hz}}$ Typ.) Wide Small-Signal Bandwidth (10 MHz Typ.) High Output Drive Capability (10V rms into 600 Ω) Wide Supply Range (± 3V to ± 20V) Wide Power Bandwidth (200 kHz) High Voltage Gain: Av = 100,000 at DC Av = 6,000 at 10 kHz High Slew-Rate: 13 V/ μ sec

APPLICATIONS

XR-5534CP

Professional Audio Equipment Instrumentation and Servo Control Telephone Channel Amplifier Low-Level Signal Processing Audio Preamplification

ORDER INFORMATION			
Part Number	Package	Operating Temperature	
XR-5534AM	Ceramic	-55°C to +125°C	
XR-5534M	Ceramic	-55°C to +125°C	
XR-5534ACN	Ceramic	0°C to +75°C	
XR-5534CN	Ceramic	0°C to +75°C	
XR-5534ACP	Plastic	0°C to +75°C	

Plastic

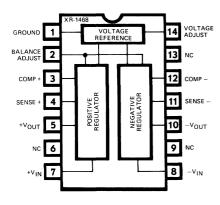
 0° C to $+75^{\circ}$ C

Voltage Regulators

XR-1468/1568 DUAL-POLARITY TRACKING VOLTAGE REGULATOR

The XR-1568/1468 is a dual-polarity tracking voltage regulator combining two separate regulators with a common reference element in a single monolithic circuit, thus providing very close balance between the positive and negative output voltages. Outputs are internally set to ± 15 volts but can be externally adjusted between ± 8.0 to ± 20 volts with a single control. The circuit features ± 100 mA output current, externally adjustable current limiting, and provision for remote voltage sensing.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Internally Set for ±15V Outputs ±100 mA Peak Output Current Output Voltages Balanced Within 1% (XR-1568) 0.06% Line and Load Regulation Low Stand-By Current Output Externally Adjustable from ±14.5 to ±20 Volts Externally Adjustable Current Limiting Remote Sensing

APPLICATIONS

Main Regulation in Small Instruments On-Card Regulation in Analog and Digital Systems Point-of-Load Precision Regulation

ORDER INFORMATION

Package	(
Ceramic	
Ceramic	
Ceramic	
	Ceramic Ceramic

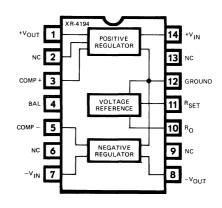
Operating Temperature

-55°C to +125°C	
0°C to +75°C	
0°C to +75°C	

XR-4194 DUAL-TRACKING VOLTAGE REGULATOR

The XR-4194 is a dual-polarity tracking regulator designed to provide balanced or unbalanced positive and negative output voltages at currents up to 200 mA. It features a single resistor to adjust both outputs between the limits of +50 mV and +42V. It is ideal for local "on-card" regulation in analog and digital systems as well as in small instruments.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Replacement for RM/RC-4194 Both Outputs Adjust with Single Resistor Load Current to ± 200 mA with 0.2% Load Regulation Low External Parts Count Internal Thermal Shutdown at T_j = 175°C External Adjustment for $\pm V_0$ Unbalancing

APPLICATIONS

On-Card Regulation in Analog and Digital Systems Main Regulation in Small Instruments Point-of-Load Precision Regulation

ORDER INFORMATION

Part Number	Package	Operating
XR-4194M	Ceramic DIP	$-55^{\circ}C$
XR-4194CN	Ceramic DIP	0° C 1

-55°C to +125°C 0°C to +75°C

Temperature

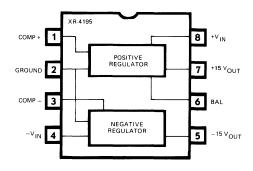
Voltage Regulators

XR-4195 \pm 15V DUAL-TRACKING VOLTAGE REGULATOR

The XR-4195 is a dual-polarity tracking regulator designed to provide balanced positive and negative 15V output voltages at currents of up to 100 mA.

The device is ideal for local "on-card" regulation, which eliminates the distribution problems associated with singlepoint regulation. Intended for ease of application, the XR-4195 requires only two external components for operation.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Replacement for RM/RC-4195±15V Operational Amplifier Power Thermal Shutdown at $T_j = 175^{\circ}C$ Output Currents to 100 mA Available in 8-Pin Plastic Mini-DIP Low External Parts Count

APPLICATIONS

On-Card Regulation Main Regulation in Small Instruments

ORDER INFORMATION

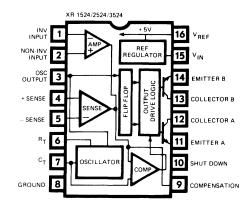
Part Number XR-4195CP Package Plastic

Operating Temperature $0^{\circ}C$ to $+ 70^{\circ}C$

XR-1524/2524/3524 PULSE WIDTH MODULATING REGULATOR

This monolithic integrated circuit contains all the control circuitry for a regulating power supply inverter or switching regulator. Included in a 16-pin dual-in-line package is the voltage reference, error-amplifiers, oscillator, pulse-width modulator, pulse-steering flip-flop, dual alternating output switches and current-limiting and shut-down circuitry. This device can be used for switching regulators of either polarity, transformer coupled DC to DC converters, transformer-less voltage doublers and polarity converters, as well as other power control applications. The XR-1524 is specified for operation over the full military temperature range of -55° C to $+125^{\circ}$ C, while the XR-2524 and XR-3524 are designed for commercial applications of 0°C to $+70^{\circ}$ C.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Replacement for SG1524/2524/3524 Complete PWM Power Control Circuitry Single-Ended or Push-Pull Outputs Lines and Load Regulation of 0.2% 1% Maximum Temperature Variation Total Supply Current Less than 10 mA Operation Beyond 100 kHz

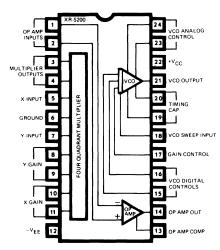
Part Number	Package	Operating Temperature
XR-1524M	Ceramic	-55° C to $+125^{\circ}$ C
XR-2524N	Ceramic	0° C to $+75^{\circ}$ C
XR-2524P	Plastic	0° C to $+75^{\circ}$ C
XR-3524CN	Ceramic	0° C to $+75^{\circ}$ C
XR-3524CP	Plastic	0° C to $+75^{\circ}$ C

Special Functions

XR-S200 MULTI-FUNCTION INTEGRATED CIRCUIT

The XR-S200 integrated circuit is a highly versatile, multipurpose circuit that contains all of the essential functions of most communication system designs on a single monolithic substrate. The functions contained in the XR-S200 include: (1) a four quadrant analog multiplier, (2) a high frequency voltage controlled oscillator (VCO) and (3) a high performance operational amplifier. The three functions can be used independently, or directly interconnected in any order to perform a large number of complex circuit functions from phase-locked loops to the generation of complex waveforms.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Three Independent Circuit Functions: A Four Quadrant Analog Multiplier A High Frequency Voltage Controlled Oscillator (VCO) A High Performance Operational Amplifier Analog and Digital Signal Conditioning A Frequency Range of 0.1 Hz to 30 MHz A Power Supply Range of ±3V to ±30V

APPLICATIONS

Phase-Locked Loops FM Demodulation FSK Detection Signal Conditioning Tracking Filters Frequency Synthesis Telemetry Coding/Decoding Linear Sweep/FM Waveform Generation

ORDER INFORMATION

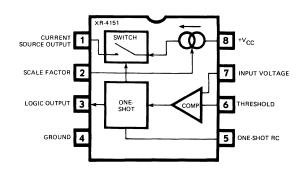
Part Number	Package
XR-S200	Ceramic

Operating Temperature 0° C to $+75^{\circ}$ C

XR-4151 VOLTAGE-TO-FREQUENCY CONVERTER

The XR-4151 is a device designed to provide a simple, low-cost method for converting a DC voltage into a proportional pulse repetition frequency. It is also capable of converting an input frequency into a proportional output voltage. The XR-4151 is useful in a wide range of applications including A/D and D/A conversion and data transmission.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Single Supply Operation (+8V to +22V) Pulse Output Compatible with all Logic Forms Programmable Scale Factor Linearity ±0.05% typical (precision mode) Temperature Stability ±100% ppm/°C typical High Noise Rejection Inherent Monotonicity Easilty Transmittable Output Simple Full-Scale Trim Single-Ended Input Also Provides Frequency-to-Voltage Conversion Direct Replacement for RC/RV/RM-4151

APPLICATIONS

Voltage-to-Frequency Conversion A/D and D/A Conversion Data Transmission Frequency-to-Voltage Conversion Transducer Interface System Isolation

ORDER INFORMATION

Part Number	Package
XR-4151P	Plastic
XR-4151CP	Plastic

Operating Temperature -40°C to +85°C 0°C to +70°C

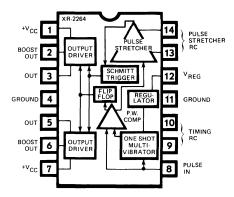
Special Functions

XR-2264/2265 **PULSE-PROPORTIONAL** SERVO CIRCUIT

The XR-2264/2265 are monolithic circuits designed for use in pulse-proportional servo systems and specifically designed for radio control applications. They are capable of controlling positions in direct proportion to the width of input pulses.

The XR-2264 can interface directly with servo motors requiring up to 350 mA of drive current. The XR-2265, with open collector outputs, can directly drive relays, optical couplers, and triacs. Both circuits can drive external PNP transistors for 500 mA output drive requirements. The XR-2264/2265, combined with a servo motor and a feedback potentiometer, form a closed-loop system.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Wide Supply Voltage Range (3.0V to 6.0V) Bidirectional Operation with Single Supply Separately Adjustable Dead Band and Pulse Stretching XR-2264 – 350 mA Source and Sink on Chip 500 mA with External PNP XR-2265 – 500 mA Sink Capability on Chip 500 mA Sink or Source Capability with External PNP

APPLICATIONS

Radio Control Remote Control Servo Driver

ORDER INFORMATION

Part Number	Package
XR-2264CP	Plastic
XR-2265CP	Plastic

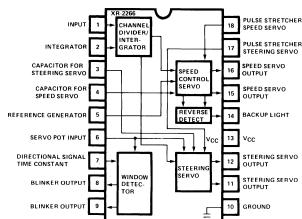
Operating Temperature

 -10° C to $+50^{\circ}$ C -10° C to $+50^{\circ}$ C

XR-2266 SERVO CONTROLLER

The XR-2266 is a monolithic servo controller system specifically designed for radio-controlled model cars. It is a self-contained system made up of two servo controller channels: one to control the direction and the speed of travel; and the other to provide the steering function. The circuit contains an internal channel separater section which automatically steers the incoming control signal to the appropriate servo controller channel.

The channel controlling the direction and the speed of travel requires external power transistors. The steering channel is completely self-contained and has an internal ±350 mA output drive capability.



FUNCTIONAL BLOCK DIAGRAM

FEATURES

Internal Channel Divider Internal Steering Servo with Direct Drive for Servomotor and Turn Signal Indicators **Directional Signal Time Constant** Externally Settable Variable Speed Control with Direct Drive for Backup Lights Wide Supply Range (3.5 -8.0 volts) Steering and Speed Servos Independently Programmed

APPLICATIONS

Radio Controlled cars

ORDER INFORMATION

Part Number	Package
XR-2266	Plastic

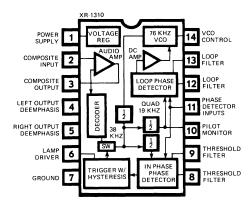
Operating Temperature 0° C to +75°C

Special Functions

XR-1310 STEREO DEMODULATOR

The XR-1310 is a unique FM stereo demodulator which uses phase-locked loop techniques to extract the right and the left audio channels from the composite signal. Using a phase-locked loop to regenerate the 38 kHz subcarrier, it requires no external L-C circuit for tuning. Alignment is accomplished with a single potentiometer.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Requires No Inductors

Low External Part Count

Simple, Noncritical Tuning by Single Potentiometer Adjustment

Internal Stereo/Monaural Switch with 100 mA Lamp Driving Capability

Wide Dynamic Range: 600 mV (RMS) Maximimum Comsite Input Signal

Operating Temperature

 -40° C to $+85^{\circ}$ C

Wide Supply Voltage Range: 8 to 14 Volts Excellent Channel Separation Low Distortion Excellent SCA Rejection

APPLICATIONS

FM Stereo Demodulation

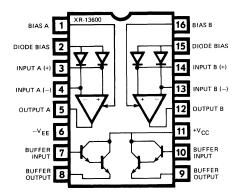
ORDER INFORMATION

Part NumberPackageXR-1310CPPlastic

XR-13600 DUAL OPERATIONAL TRANSCONDUCTANCE AMPLIFIER

The XR-13600 consists of 2 programmable transconductance amplifiers with high input impedance and push-pull outputs. The 2 amplifiers share common supplies but otherwise operate independently. Each amplifier's transconductance is directly proportional to its applied bias current. To improve signal-to-noise performance, predistortion diodes are included on the inputs; the use of these diodes results in a 10 dB improvement referenced to 0.5% THD. Independent Darlington emitter followers are included to buffer the outputs.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Replacement for LM-13600 Transconductance Adjustable Over 4 Decades Excellent Transconductance-Control Linearity Uncommitted Darlington Output Buffers On-Chip Predistortion Diodes Excellent Matching Between Amplifiers Wide Supply Range: ±2V to ±18V

APPLICATIONS

Current-Controlled Amplifiers Current-Controlled Impedances Current-Controlled Filters Current-Controlled Oscillators Multipliers/Attenuators Sample and Hold Circuits Electronic Music Synthesis

ORDER INFORMATION

Part Number	Package	Operating
XR-13600CP	Plastic	0°C

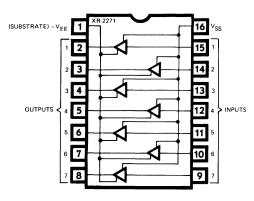
Operating Temperature $0^{\circ}C$ to $+75^{\circ}C$

Display Drivers

XR-2271 FLUORESCENT DISPLAY DRIVER

The XR-2271 is a monolithic 7-digit or 7-segment driver designed to interface MOS logic with fluorescent displays. The circuit features active high logic and low input current and it can drive all seven digits with complete input and output isolation. No external parts are necessary to interface fluorescent displays.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Active High Logic Low Input Current Complete Input Output Isolation Output Pull Up Resistors On Chip No External Parts Required to Drive Fluorescent Displays

APPLICATIONS

Fluorescent Display Driver MOS Logic/High-Voltage Interface

ORDER INFORMATION

Part Number XR-2271CN XR-2271CP

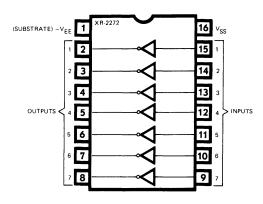
Package Ceramic Plastic

Operating Temperature $0^{\circ}C$ to $+75^{\circ}C$ $0^{\circ}C$ to $+75^{\circ}C$

XR-2272 HIGH-VOLTAGE 7-DIGIT DISPLAY DRIVER

The XR-2272 is a monolithic high-voltage 7-digit driver specifically designed to drive a gas-filled digit display. The main application is to act as buffers between MOS outputs and the anodes of a gas discharge panel.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Active Low Inputs Versatile Circuits for a Wide Range of Display Applications High Breakdown Voltages Low Power Dissipation 16-Pin Dual-in-Line Plastic Package

APPLICATIONS

Gas-Discharge Display Driver Panaplex® Display Driver MOS Logic to High-Voltage Interface

ORDER INFORMATION

Part Number
XR-2272CP

Package Plastic

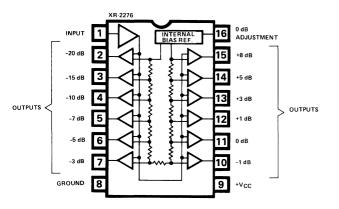
Operating Temperature 0° C to $+75^{\circ}$ C

Display Drivers

XR-2276 BAR-GRAPH DISPLAY GENERATOR

The XR-2276 is a 12-point level-detector circuit particularly designed for interfacing with fluorescent displays. The circuit is comprised of an input buffer amplifier, 12 high-gain comparators, an internal voltage reference and a biassetting resistor string. All of the twelve comparator stages have independent buffered outputs. Each of the comparators have a threshold level higher than the preceeding comparator stage. With no input signal, all of the comparators are "off" and all the outputs are at a *low* state. As the input level is increased, the outputs successively switch to their *high* state, at 12 discrete input levels. These threshold levels are set to be within the range of -20 dB to +8 dB; with reference to a 0 dB level setting.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Can Drive Fluorescent or LED Displays High Input Impedance Internal Pull-Down Resistors Logarithmic Display Characteristics External Reference Level Adjustment

APPLICATIONS

Bar-Graph Display Generator 12-Point Display Driver Audio Level Indicator Channel Separation Indicator 12-Point Digital Controller Sequential Display Generator

ORDER INFORMATION

Part NumberPackageXR-2276CPPlastic

Operating Temperature $0^{\circ}C$ to $+75^{\circ}C$

XR-2277/XR-2278 DOT OR BAR-GRAPH DISPLAY GENERATORS

The XR-2277 and the XR-2278 are 12-point level-detector circuits designed for interfacing directly with LED movingdot or bar-graph displays. Each circuit is comprise of an input buffer amplifier and a set of 12 comparator of the are biased from an internal voltage reference and a stor string. Each comparator provides a high impedance arrent source output; each of the output currents is a losely matched and can be adjusted simultaneously with a single external setting resistor. The control signal applied to the mode-select pin determines whether the display is driven in a moving dot or bar-graph format.

The XR-2277 has 12 discrete output levels, over a range of -30 dB to +6 dB, referenced to an example of the transformed by the transformation of transfor

FUNCTIONAL BLOCK DIACE AM

FEATURE

Direct LE: Interface Constant-Current Outputs Adjurate Output Currents High Cont Impedance Example Mode-Select for Dot/Bar-Graph Format Adjurable/zero dB Reference

APPLICATIONS

Bar-Graph Display Generator and Driver Dot Display Generator Audio Level Indicator Sequential Display Indicator

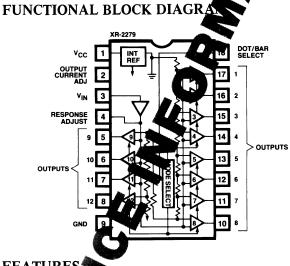
Part Number	Package	Operating Temperature
XR-2277CP	Plastic	0°C to +75°C
XR-2278CP	Plastic	0° C to +75° C

Display Drivers

XR-2279 DOT AND BAR-GRAPH DISPLAY GENERATOR

The XR-2279 is a 12-point logarithmic level-detector circuit comprised of an input buffer amplifier and a set of 12 voltage comparators. The circuit produces 12 discrete output levels, spaced in three dB intervals, over a dynamic range of -27 dB to +6 dB, referenced to an externally adjusted zero dB level. It is designed for interfacing directly with the moving-dot or bar-graph displays. Each of the comparator outputs provides a high impedance constant-cur en drive which is well matched and can be adjusted by a supernal resistor setting.

The output can be either in a moving-dot a continuous bar-graph format, depending on the control voltage applied to the mode-select pin.



FEATURES

Direct LED Interface Constant/the B/Step Logarithmic Scale External Mode Select for Dot/Bar-Graph/Formats Adjustable, utput Current Levels Adjustable/zero dB Reference



Bar-Caph Generator Moving-Dot Display Generator Logarithmic Level Indicator Sequential Level Indicator

ORDER INFORMATION

Part Number	
XR-2279CP	

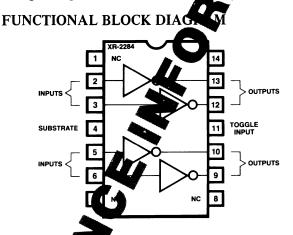
Package Plastic

Operating Temperature
0°C to +75°C

XR-2284 HIGH VOLTAGE PLASMA DISPLAY DRIVER

The XR-2284 is a four channel display driver circuit especially designed for interfacing with high voltage ac plasma display systems. Each driver array can be used for either the segment or the column (or digit) drive, and several giver arrays can be "stacked" together to drive a large of display segments or columns.

All four channels of the driver IC are driven by non ac toggle voltage, each output can sink or source dp to 100 mA of load current and can operate with le fre-1d levels of quencies of up to 200 kHz. The input thre each of the driver channels is compatible with TTL or perate with CMOS logic levels. The XR-2284 is designed 360 volt ac plasma systems and has a min. um stand-off the XR-2284 C, voltage of 90 volts. The commercial vers has a maximum is designed for 240 volt plasma system voltage rating of 60 volts.



FEATURES

High Standow Voltage $(\geq 90\%$ for XR-2284; $\geq 60V$ for XR-2284 C) Very Low C Standby Power $(\approx 25 \text{ nrw/channel at 100 kHz})$ Zero be Standby Power 106 to output Drive Capability TTL and CMOS Compatible Inputs

APALICATIONS

High Voltage AC Plasma Panels High Voltage Pulsed Displays Pulsed AC Switching

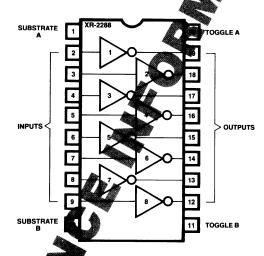
Part Number	Package	Operating Temperature
XR-2284P	Plastic	0°C to +75°C
XR-2284CP	Plastic	0°C to +75°C

Display Drivers

XR-2288 HIGH-VOLTAGE AC PLASMA DISPLAY DRIVER

The XR-2288 is an eight channel high voltage display driver circuit especially designed for ac plasma display. It contains the equivalent of two XR-2284 type driver comes in a single IC package. Each driver channel can sink errouvce up to 100 mA of capacitive load current and coorrate with toggle frequencies up to 200 kHz. The XN-288 is designed to operate with 360 volt ac plasma systems and has a minimum stand-off voltage of 90 volt. The commercial version, the XR-2288 C, is designed for 240 volt plasma systems and has a maximum voltage rating of forvolts.

FUNCTIONAL BLOCK DIAGRA



FEATURES

High Stand of Voltage (90 volts, typical) Eight In predent Driver Channels Very C Standby Power (a SimW/channel at 100 kHz) Zee Dt Standby Power 100 m. Output Drive Capability C and CMOS Compatible Inputs

APPLICATIONS

High Voltage AC Plasma Panels High Voltage Pulsed Displays Pulsed AC Switching

ORDER INFORMATION

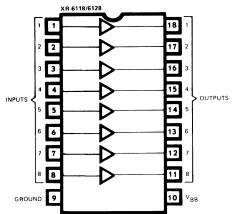
Part Number	Package
XR-2288P	Plastic
XR-2288CP	Plastic

Operating Temperature 0°C to +75°C 0°C to +75°C

XR-6118/6128 FLUORESCENT DISPLAY DRIVER

The XR-6118 and the XR-6128 are high-voltage display driver arrays which are designed to interface between lowlevel digital logic and vacuum fluorescent displays. Each circuit consists of eight independent signal channels comprised of Darlington output stages and common-emitter type inputs. All stages on the chip share common power supply and ground connections. Both device types are capable of driving digits and/or segments of fluorescent displays, and all of the eight outputs can be activated simultaneously. The XR-6118 is compatible with TTL, Schottky TLL, DTL and 5-Volt CMOS logic families. The XR-6128 is intended for use with PMOS or CMOS logic families operating with supply voltages of 6V to 15V.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Replacement for Sprague UDN-6118A and UDN-6128A Digit or Segment Drivers Low Input Current Internal Output Pull-Down Resistors Low Power High Output Breakdown Voltage (75 V, min.)

APPLICATIONS

Fluorescent Driver Gas-Discharge Display Driver High-Voltage Switching

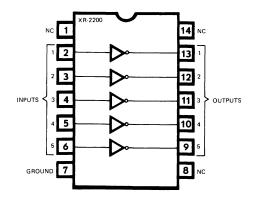
Part Number	Package	Operating Temperature
XR-6118P	Plastic Plastic	0°C to +85°C 0°C to +85°C
XR-6128P	Flastic	0 C 10 +85 C

High Current Drivers

XR-2200 HAMMER DRIVER

The XR-2200 is an array of five Darlington transistor pairs which are capable of driving high-current loads such as solenoids, relays, and LED's. Each of the five circuits contained on the XR-2200 is capable of sinking up to 400 mA. The XR-2200 was specifically designed for use with 14V to 25V PMOS devices.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Output Capability of 400 mA for each Driver Drivers May be Used in Parallel for Increased Output Drive Capability Input is Directly Compatible with PMOS Outputs

. . .

APPLICATIONS

Printing Calculator Hammer Driver High Current LED Driver Solenoid and Relay Driver Tungsten Lamp Driver High Current Switch

ORDER INFORMATION

Part Number XR-2200CP

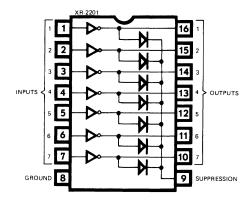
Package Plastic

Operating Temperature -25° C to $+75^{\circ}$ C

XR-2201/2202/2203/2204 HIGH-VOLTAGE, HIGH-CURRENT DARLINGTON TRANSISTOR ARRAYS

The XR-2201/2202/2203/2204 Darlington transistor arrays are comprised of seven silicon NPN Darlington pairs on a single monolithic substrate. All feature open-collector outputs and internal protecton diodes for driving inductive loads. Peak inrush currents of up to 600 mA are allowable, making them also ideal for driving tungsten filament lamps. Although the maximum continuous collector current rating is 500 mA for each driver, the outputs may be paralleled to achieve higher load current capability.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

High Peak Current Capability: 600 mA Internal Protection Diodes for Driving Inductive Loads Directly Compatible with TTL, CMOS, PMOS, and DTL Logic Families Exact Replacement for Sprague Types ULN2001A, ULN2002A, ULN2003A, and ULN2004A

APPLICATIONS

Solenoid and Relay Driver High Current LED Driver Printing Calculator Hammer Driver High Current Switch Tungsten Lamp Driver

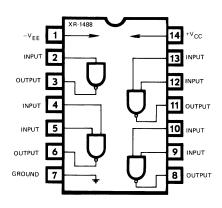
Part Number	Package	Operating Temperature
XR-2201CP	Plastic	0° C to +85°C
XR-2202CP	Plastic	0°C to +85°C
XR-2203CP	Plastic	0° C to $+85^{\circ}$ C
XR-2204CP	Plastic	0° C to $+85^{\circ}$ C

Line Interface Circuits

XR-1488 QUAD LINE DRIVER

The XR-1488 is a monolithic quad line driver designed to interface data terminal equipment with data communications equipment. It meets EIA Standard No. RS232C. This circuit features output current limiting, independent positive and negative power supply driving elements, and compatibility with all DTL and TTL logic families.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Replacement for MC1488 Current Limited Output Compatible with DTL and TTL Logic Meets EIA Standard RS232C

APPLICATIONS

Data-Terminal Interface Driving Capacitive Loads Data Bus Interface

ORDER INFORMATION

Part NumberPackageXR-1488NCeramicXR-1488PPlastic

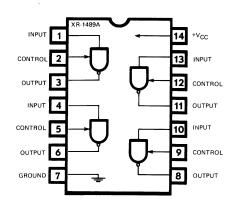
Operating Temperature $0^{\circ}C$ to $+75^{\circ}C$ $0^{\circ}C$ to $+75^{\circ}C$

XR-1489A QUAD LINE RECEIVER

The XR-1489A is a monolithic quad line receiver especially designed for data bus interface. Each of the line receiver sections have adjustable hysteresis characteristics for improved noise-rejection. The input and output levels of the circuit are designed to provide direct interface between RS232C data bus standards and the DTL or TTL type logic levels.

The XR-1489A line receiver and the XR-1488 line driver circuits are designed to provide the complete interface function between terminal equipment and the data communication or telemetry systems.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Direct Replacement for MC1489A Current Limited Output Compatible with DTL and TTL Logic Meets EIA Standard RS232C

APPLICATIONS

Data-Bus Interface Microprocessor Interface Remote Terminal Interface

ORDER INFORMATION

Part Number	Package
XR-1489AN	Ceramic
XR-1489AP	Plastic

Operating Temperature 0°C to +75°C 0°C to +75°C

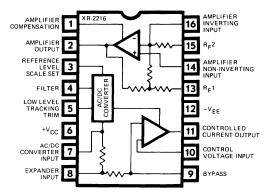
Telecommunication Circuits

XR-2216 MONOLITHIC COMPANDOR

The XR-2216 is a monolithic audio frequency compandor designed to compress or expand the dynamic range of speech or other analog signals transmitted through telecommunication systems. External circuitry determines whether the circuit is connected as either a compressor or an expander.

The circuit features four basic blocks: (1) an internal voltage reference, (2) an AC/DC converter, (3) an impedance converter, and (4) a high-gain operational amplifier. The XR-2216 can be operated with positive or negative single supply systems or dual power supplies over a 6V to 20V power supply range.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Functions as Either a Compressor or an Expander Wide Dynamic Range: 60 dB Wide Supply Range: 6 to 20 Volts Excellent Transfer Function Tracking Low Power Supply Drain Controlled Attack and Release Times Low Noise and Low Distortion

APPLICATIONS

Telephone Trunk-Line Compandor Speech/Data Compression and Expansion Telecommunications Systems Mobile Communications Analog Data Processing

ORDER INFORMATION

Operating Temperature

XR-2216CN XR-2216CP

Part Number

Package Ceramic Plastic

 -40° C to $+60^{\circ}$ C -40° C to $+60^{\circ}$ C

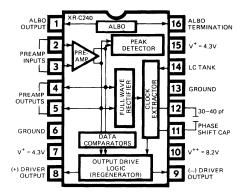
XR-C240 MONOLITHIC PCM REPEATER

The XR-C240 is a monolithic repeater circuit for Pulse-Code Modulated (PCM) telephone systems. It is designed to operate as a regenerative repeater at 1.544 Megabits per second (Mbps) data rates on T-1 type PCM lines.

The XR-240 monolithic IC is packaged in a hermetic 16pin DIP package and is designed to operate over a temperature range of -40° C to $+85^{\circ}$ C. It contains all the basic functional blocks of a regenerative repeater system including Automatic Line Build-Out (ALBO) and equalization, and is insensitive to reflections caused by cable discontinuities.

Compared to conventional repeater designs using discrete components, the XR-C240 monolithic repeater IC offers greatly improved reliability and performance and provides significant savings in power consumption and system cost.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Contains all Active Components of PCM Repeater On-Chip ALBO Equalizer High-Current Output Drivers Low-Power Consumption Increased Reliability over Discrete Designs 2 Megabit Operation Capability

APPLICATIONS

PCM Repeater for T-1 Systems Repeater for 2 Megabit PCM Systems

ORDER INFORMATION

Part Number	Package
XR-C240	Ceramic

Operating Temperature -40° C to $+85^{\circ}$ C

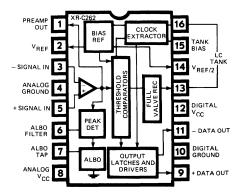
Telecommunication Circuits

XR-C262 HIGH-PERFORMANCE PCM REPEATER

The XR-C262 is a high-performance monolithic repeater IC for pulse-code modulated (PCM) telephone lines. It is designed to operate as a regenerative repeater at 1.544 Megabits per second (Mbps) data rates on T-1 type PCM lines.

The XR-C262 operates with a single 6.8 volt power supply and with a typical supply current of 13 mA. It provides bipolar output drive with high-current handling capability. The clock-extractor section of XR-262 uses the resonanttank circuit principle, rather than the injection-locked oscillator technique used in earlier monolithic repeater designs. The bipolar output drivers are designed to go "off" state automatically when there is no input signal present.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Contains all Necessary Active Components of a PCM Repeater Uses L-C Tank for Clock Recovery

Low-Voltage Operation (6.8 volts) Low-Current Drain (13 mA, typical) High-Current Bipolar Output Drivers On-Chip ALBO Equalizer Automatic Zero-Input Shutdown Increased Reliability Over Discrete Designs 2 Megabit Operation Capability

APPLICATIONS

PCM Repeater for T-1 Systems Repeater for 2 Megabit PCM Systems

ORDER INFORMATION

Part NumberPackageXR-C262Ceramic

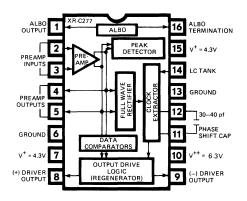
Operating Temperature -40°C to +85°C

XR-C277 LOW-VOLTAGE PCM REPEATER

The XR-C277 is a monolithic repeater circuit for Pulse-Code Modulated (PCM) telephone systems. It is designed to operate as a regenerative repeater at 1.544 Megabits per second (Mbps) data rates on T-1 type PCM lines. It is packaged in a hermetic 16-pin CERDIP package and is designed to operate over a temperature range of -40° C to $+85^{\circ}$ C. It contains all the basic functional blocks of a regenerative repeater system including Automatic Line Build-Out (ALBO) and equalization, and is insensitive to reflections caused by cable discontinuities.

The key feature of the XR-C277 is its ability to operate with low supply voltages (6.3 volts and 4.3 volts) with a supply current of less than 13 mA. Compared to conventional repeater designs using discrete components, the XR-C277 monolithic repeater IC offers greatly improved reliability and performance and provides significant savings in power consumption and system cost.

FUNCTIONAL BLOCK DIAGRAM



FEATURES

Contains all Active Components of PCM Repeater Low-Voltage Operation (6.3 volts) Low-Power Dissipation (13 mA) On-Chip ALBO Equalizer High-Current Output Drivers Increased Reliability over Discrete Designs 2 Megabit Operation Capability Pin-Compatible with XR-C240

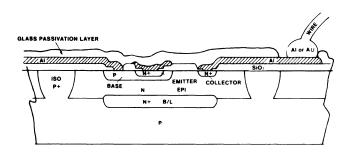
APPLICATIONS

PCM Repeater for T-1 Systems Repeater for 2 Megabit PCM Systems

Part Number	Package	Operating Temperature
XR-C277	Ceramic	-40° C to $+85^{\circ}$ C

Monolithic Chips for Hybrid Assemblies

The major performance characteristics of Exar products are also available in chip form. All chips are 100% electrically tested for guaranteed DC parameters at 25° C; and 100% visually inspected at 30x to 100x magnification using Exar's standard visual inspection criteria or MIL-STD-883, Method 201, depending on the individual customer requirements. Each chip is protected with an inert glass passivation layer over the metal interconnections. The chips are packaged in waffle-pack carriers with an anti-static shield and cushioning strip plated over the active surface to assure protection during shipment. All chips are produced on the same wellproven production lines that produce Exar's standard encapsulated devices. The Quality Assurance testing of dice is provided by normal production testing of packaged devices.



Typical Bipolar Chip Cross Section

FEATURES

DC Parameters Guaranteed at 25°C 100% Visual Inspection Care in Packaging 100% Stabilization Bake (Wafer Form) 10% LTPD on DC Electrical Parameters

CHIPS IN WAFER FORM

Probed and inked wafers are also available from Exar. The hybrid microcircuit designer can specify either scribed or unscribed wafers and receive a fully tested silicon wafer. Rejected die are clearly marked with an ink dot for easy identification in wafer form.

ELECTRICAL PARAMETERS

Probing the IC chips in die form limits the electrical testing to low level DC parameters at 25° C. These DC parameters are characteristic of those parameters contained on the individual device data sheet and are guaranteed to an LTPD of 10%.

The AC parameters, which are similar to those in the standard Exar device data sheets, have been correlated to selected DC probe parameters and are guaranteed to an LTPD of 20%.

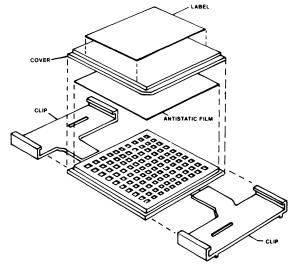
HANDLING PRECAUTIONS AND PACKAGING OPTIONS

Extreme care must be used in the handling of unencapsulated semiconductor chips or dice to avoid damage to the chip surface. Exar offers the following three handling or packaging options for monolithic chips supplied to the customer:

Cavity or Waffle Pack: The dice are placed in individual compartments of the waffle pack (see figure). The plastic snap clips permit inspection and resealing.

Vial Pack: The vial is filled with inert freon TF and a plastic cap seals the vial. The freon acts as a motion retarder and cleansing agent.

Wafer Pack: The entire wafer is sandwiched between two pieces of mylar and vacuum sealed in a plastic envelope.



Typical Cavity Pack (Waffle Pack)

Semi-custom Bipolar Program

The Exar bipolar semi-custom design program offers a variety of "semi-custom" chips to fulfill various application performance requirements and complexities.

These semi-custom chips offer a unique method of manufacturing an almost unlimited variety of custom linear and digital integrated circuits with greatly reduced cost and development time. Exar makes this possible by stocking wafers that are completely fabricated except for the final process step of device interconnection which metalizes the selected components together in the required circuit configurations.

BIPOLAR SEMI-CUSTOM CHIPS

Chip Type	Chip Size in Mils	Breakdown Voltage	NPN	PNP
A100	73 X 83	20V	60	18
B100	85 X 85	20V	69	12
C100A	56 X 62	20V	23	8
D100	80 X 80	36V	50	16*
F100	91 X 110	20V	97	32*
G100	90 X 90	20V	60	18*
J100	61 X 65	20V	38	12*
X100	115 X 95	75V	34	16
	1	1	1	1

*Dual collector PNP transistor

Exar offers a design kit which contains simple instructions and guidelines for designing the metal mask as well as actual breadboard components (consisting of NPN and PNP arrays and integrated resistors), which are representative of the devices available on the semi-custom chips. This provides the design engineer with the ability to closely evaluate his design performance prior to integrating it on a monolithic chip.

Semi-custom I² L Program

With the introduction of the I^2L Gate-Array chips, Exar has extended its semi-custom design program to the Integrated Injection Logic (I^2L) technology. This unique method of custom LSI development technique now makes it possible to manufacture an almost unlimited variety of digital or analog/digital circuits using I^2L technology, at a greatly reduced development cost and time.

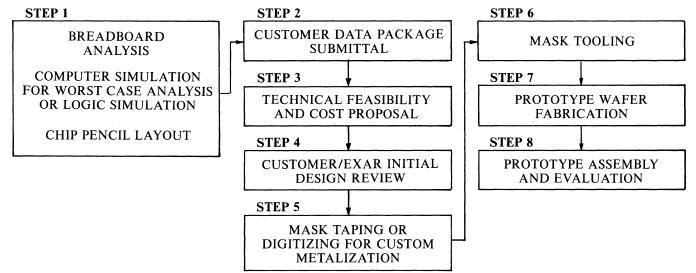
I²L SEMI-CUSTOM CHIPS

Characteristics	Chip Type			
Characteristics	XR-200	XR-300	XR-400	XR-500
Chip Size (mils)	98 X 119	104 X 146	119 X 156	122 X 185
I ² L Gates	192	288	256	520
Max. Operating				
Voltage	1			
A-Option	6V	6V	6V	6V
B-Option	15V	15V	15V	15V
Bipolar I/O				
Interfaces	24	28	18	40
Bonding Pads	30	34	40	42

The XR-300 and the XR-500 gate-arrays are intended primarily for digital LSI designs. The XR-400 gate-array features the advantages of combining analog and digital functions on the same IC chip. These I^2L gate-array chips are customized using two or more custom mask patterns which are simultaneously generated from a pencil layout, using Exar's unique computerized mask generation technique. In this manner, the chip layout is greatly simplified and gate-utilization efficiency is increased.

Exar also offers an I^2L design kit which is intended to familiarize the designer with the basic features of I^2L technology and provide helpful design guidelines in reducing his design from concept to breadboard and finally to the IC layout stage.

TYPICAL FLOW FOR SEMI-CUSTOM DEVELOPMENT



Full Custom Development

Exar offers a complete design and production capability for full-custom IC development using Exar's bipolar and I^2L technologies. This provides an excellent complement to Exar's unique semi-custom capability.

Exar's full-custom IC development and production capabilities offer complete flexibility to meet changing customer needs or design problems. We can develop a complete custom IC starting from your "black-box" specifications or reduce your working breadboard prototype to a monolithic chip. Alternately, if you have the facilities and resources to do the IC design and the layout, Exar will provide you with the device characteristics and IC layout rules for the particular process suitable to your design and review your IC layout for you. Then, Exar can generate the IC tooling and fabricate your IC prototypes for you.

Exar's bipolar process technology is compatible with the manufacturing processes available from many of the other IC manufacturers. Thus, if you have developed a set of IC tooling with another manufacturer and would like an alternate or substitute supplier for your custom IC product, in most cases your existing IC tooling may be directly compatible with Exar's technology.

Exar's Engineering Department has two custom IC design groups dedicated to the development of linear and digital custom LSI. We pride ourselves in our flexibility and quick response to your needs.

CONVERTING SEMI-CUSTOM TO FULL CUSTOM

Exar offers the unique ability to start a program using a combination of semi-custom bipolar and/or I²L arrays during the early phases of a customer's product, taking full advantage of the low tooling cost and short development cycle. As a customer's product matures and its market expands, resulting in higher volume production run rates, Exar can convert the multiple semi-custom chip approach into a single custom IC, achieving a cost reduction and in many cases, a performance improvement. The significant advantage of this type of program is that the risk associated with a custom development is greatly reduced; the IC design approach has been proven, production "bugs" are out of your product and your production line continues to flow during the full custom chip development. Once the custom chip is completely characterized and found acceptable, the semi-custom IC system in your product can be phased-out while the full-custom IC is being phased-in.

Exar is the only company that can offer you the advantages of semi-custom and full-custom bipolar design programs because of our in-house complete semiconductor manufacturing capability.

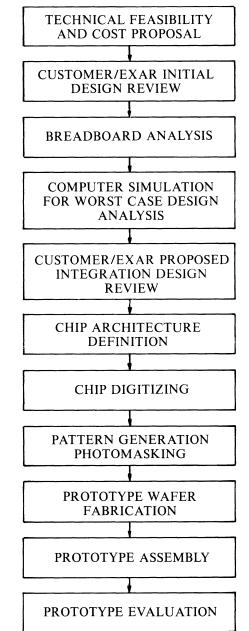
YOUR FIRST STEP

The following technical data package is required in order for Exar to provide you with a firm quotation for your fullcustom development program:

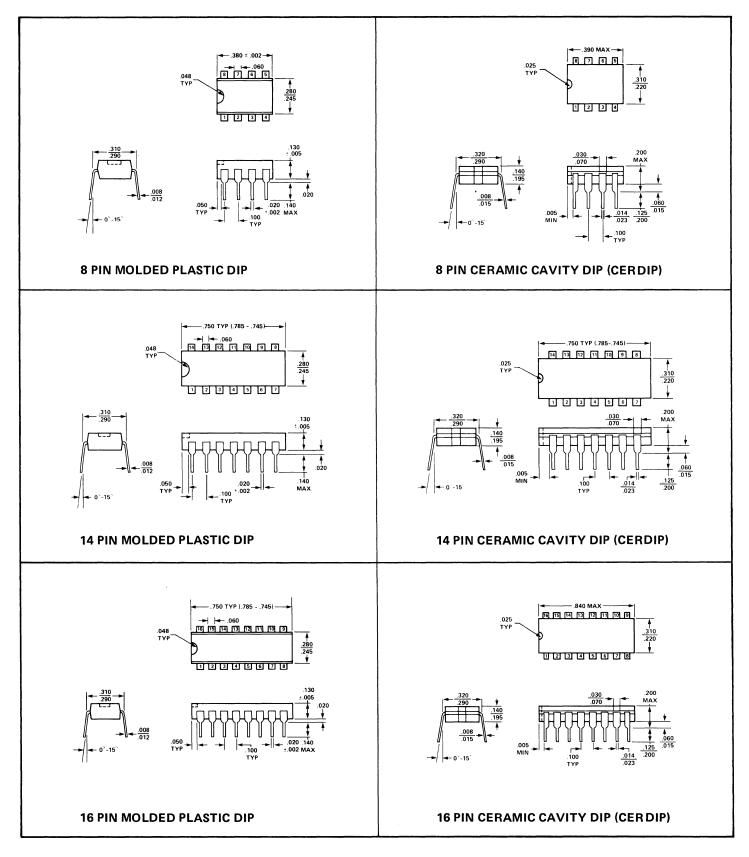
1. Circuit block diagram with sub-blocks (as required).

- 2. Circuit Schematic or Logic Diagram.
- 3. Description of circuit operation and pertinent application information.
- 4. Preliminary or objective device specification indicating min/max conditions and limits for the critical parameters (i.e., input/output voltage and current levels, operating frequency, timing diagrams, input/output impedances, power dissipation, etc.)
- 5. Production requirements and the desired development time table.

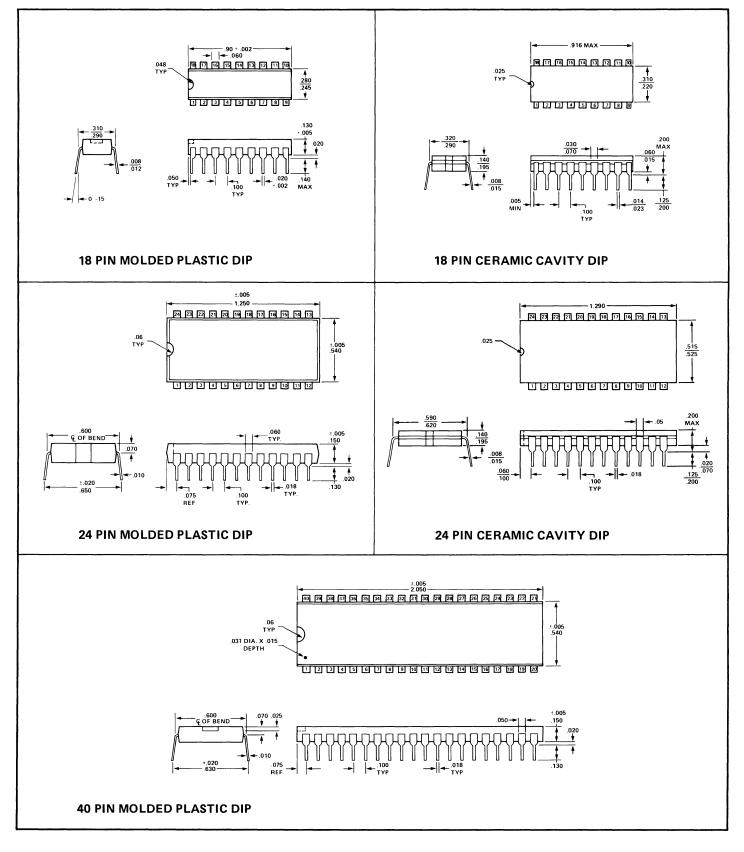
FLOW-CHART OF TYPICAL FULL CUSTOM DEVELOPMENT PROGRAM



Packaging Information



Packaging Information



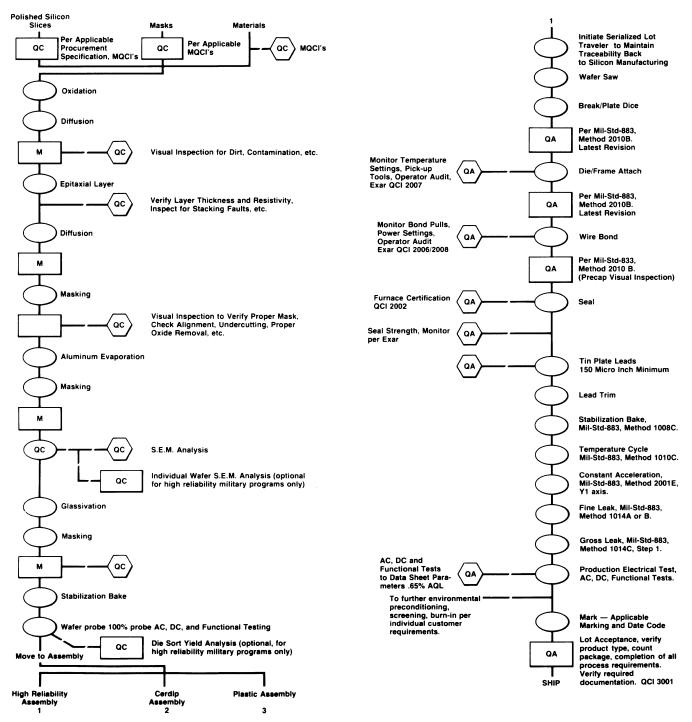
QUALITY ASSURANCE STANDARDS

The quality assurance program at Exar Integrated Systems defines and establishes standards and controls on manufacturing, and audits product quality at critical points during manufacturing. The accompanying Manufacturing/QA process flows illustrate where quality assurance audits, by inspection or test, the manufacturing process. The insertion of these quality assurance points is designed to insure the highest quality standards are maintained on Exar product during its manufacture.

Realizing that these standard Manufacturing/QA process flows do not meet the needs of every customer's specific requirements, Exar quality assurance can negotiate and will screen product to meet any individual customer's specific requirement.

All products ending with the suffix M are fully screened to the requirements of MIL-STD-883, Method 5004, Condition C.





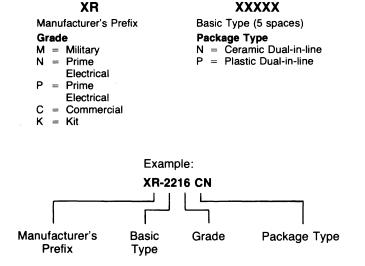
Wafer Fabrication/QA Flow

Cerdip Assembly/QA Flow

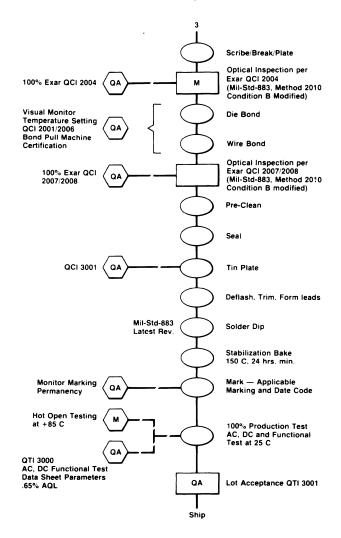
Scribe/Break/Plate Optical Inspection per Exar QCI 2004 (Mil-Std-883, Method 2010 100% Exar QCI 2004 QA м Condition B modified) QCI 2001/2006 Die/frame Attach Monitor Temperature QA Setting, Bond Pull, Machine Certification Wire Bond Optical Inspection 100% Exar QCI 2007, 2008 per Exar QCI 2001/2008 (Mil-Std-883 Method 2010 QA м Condition B Modified) ΄ QΑ Furnace Certification Seal QCI 2002 QA Tin Plate QA Trim Monitor Seal Strength Per Exar QCI 2002 Fine Leak, 5 x 10 ⁷ cc/sec Mil-Std-883 Gross Leak, Bubble Test Stabilization Bake, 150 C. 24 hrs. min., 100% Production Testing, AC, DC, and Functional Test at 25 C. QA QTI 3000 AC, DC Functional Test Data Sheet Parameter .65% AQL Marking — Applicable Marking and Date Code Lot Acceptance QTI 3001 OA Ship

PRODUCT ORDERING INFORMATION

Part Identification







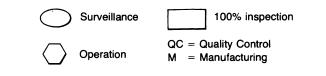
Definition of Symbols:

- M = Military Grade Part, Ceramic Package Only.
 All Military Grades have been processed to MIL-STD-883
 Level C, and are guaranteed to operate over military temperture range.
- N = Prime Grade Part, Ceramic Package.
- P = Prime Grade Part, Plastic Package.
- CN = Commercial Grade Part, Ceramic Package.
- CP = Commercial Grade Part, Plastic Package.

N, P, CN and CP parts are electrically identical and guaranteed to operate over 0°C to + 75°C range unless otherwise stated. In addition, N and P parts generally have operating parameters more tightly controlled than the CN or CP parts.

For details, consult Exar Sales Headquarters or Sales /Technical Representatives.

Legend:



Application Notes

Exar's Applications Engineering Department has prepared a comprehensive set of application notes and information in Exar's products and technologies. A list of these application notes, along with a brief description of their contents, is given below:

AN-01: Stable FSK Modems Featuring the XR-2206, XR-2207 and XR-2211

Design of stable full-duplex FSK modems is described using the XR-2206 or the XR-2207 as the modulator, and the XR-2211 as the demodulator with carrier-detection capability. Complete design examples are given for FSK modems covering mark/space frequencies from a few Hertz to 100 KHz.

AN-02: XR-C240 Monolithic PCM Repeater

The principle of operation of the XR-C240 monolithic regenerative repeater IC is described. Design examples and external connections of the circuit are discussed for applications in T-1 type 1.544 Megabit PCM telephone lines.

AN-03: Active Filter Design With IC Op Amps

Fundamentals of active filters are discussed, transfer functions and design equations for various classes of high-, lowand bandpass filters are given. Particular design examples are provided for FSK modem filters, using the XR-4202 programmable quad op amp.

AN-04: XR-C277 Low-Voltage PCM Repeater IC

The design principles and the applications of the XR-C277 low-voltage (6.3 volt) regenerative PCM repeater are described. The monolithic IC contains all the basic functional blocks of a conventional PCM repeater, including the automatic line build-out section. Circuit connection diagrams and application examples are given for operation in 1.544 Megabit T-1 type PCM telephone systems.

AN-05: Tri-State FSK Modem Design Using XR-2206/ XR-2211

Design of FSK modems with carrier detection and control capability are discussed. Such a "tri-state" modem uses a third carrier frequency for control functions, in addition to the normal "mark" and "space" frequencies used in conventional "bi-state" FSK systems. This carrier control feature allows each transmitter in a modem system to be automatically interrogated, one at a time, by a control processor, without interference from other modem transmitters within the system.

AN-06: Precision PLL System Using XR-2207/XR-2208 A two-chip versatile phase-locked loop system is described, using the XR-2207 oscillator as the VCO, and the XR-2208 multiplier as the phase detector. The resulting PLL system features 20 ppm/°C temperature stability. Design equations are given to tailor the circuit parameters to specific applications.

AN-07: Single-Chip Frequency Synthesizer Employing the XR-2240

The operation of the XR-2240 programmable/counter IC as a frequency synthesizer is described. The circuit can simultaneously multiply an input frequency by an integer modulus M, and divide it by a different modulus N+1. Thus, a wide range of non-integer output frequencies can be produced from a single input reference frequency.

AN-08: Dual-Tone Decoding with XR-567 and XR-2567 Application examples are given for simultaneous or sequential decoding of dual-tone control signals using either two XR-567 PLL tone decoders, or a single XR-2567 dual tone decoder. The examples include high-speed, narrow-band tone detection and Touch-Tone® decoding.

AN-09: Sinusoidal Output From XR-215 Monolithic PLL Circuit

A simple circuit technique is described to convert the VCO output of the XR-215 into a low-distortion sinewave. The external sinewave shaping circuit is obtained using the XR-C101 monolithic NPN transistor array.

AN-10: XR-C262 High-Performance PCM Repeater

The design principle and the electrical characteristics of the XR-C262 high-performance PCM repeater IC are described. The circuit contains all the active components necessary for a regenerative PCM repeater system and operates with a single 6.8 volt power supply. Circuit connection and application examples are given for its use in 1.5 Megabit or 2 Megabit PCM systems.

AN-11: A Universal Sinewave Converter Using the XR-2208 and XR-2211

A circuit technique is described which can convert *any* periodic waveform into a low-distortion sinewave. The circuit operation is completely independent of input waveform amplitude and frequency as long as the input signal is periodic, and can operate over a frequency range of .1 Hz to over 100 KHz.

Application Notes

AN 12: Designing High Frequency Phase-Locked Loop Carrier-Detector Circuits

A design technique is described for high frequency tone or carrier detection. The two-chip circuit uses either the XR-210 or the XR-215 PLL circuit, in conjunction with the XR-2228 multiplier/detector, and can operate with carrier frequencies up to 20 MHz.

AN-13: Frequency Selective AM Detection Using Monolithic Phase-Locked Loops

Design of frequency selective coherent AM and AM/FM demodulator systems is described using the XR-2228 Multiplier/Detector and the XR-215 or the XR-2212 PLL ICs.

AN-14: A Complete Function Generator System Using the XR-2206

A laboratory quality self-contained function generator system is described, using the XR-2206 waveform generator IC. Complete circuit connection diagram, parts list and assembly instructions are given for a DC to 100 kHz self-contained function generator system with AM/FM capability and triangle, sine and square wave output.

AN-15: An Electronic Music Synthesizer Using the XR-2207 and the XR-2240

Design of a simple, low-cost "music synthesizer" system is described. The electronic music synthesizer is comprised of the XR-2207 voltage controlled oscillator IC which is driven by the pseudo-random binary pulse pattern generated by the XR-2240 counter/timer circuit.

AN-16: Semi-Custom LSI Design with I²L Gate Arrays

A unique design approach to developing complex LSI systems is described using XR-300 and XR-500 I^2L gate arrays. This technique greatly reduces the design and tooling cost and the prototype fabrication cycle associated with the conventional full-custom IC development cycle; and thus makes custom ICs economically feasible even at low production volumes.

AN-17: XR-C409 Monolithic I²L Test Circuit

A monolithic test circuit has been developed for evaluation of speed and performance capabilities of Exar's Integrated Injection Logic (I²L) technology. This test circuit, designated the XR-C409, is intended to familiarize the I²L user and the system designer with some of the performance features of I²L such as its frequency capability and powerspeed tradeoffs.

Technical Literature

Exar's technical staff and applications engineers have prepared a number of comprehensive Data Books which cover some of the key features and applications of Exar's IC products. These Data Books also present a number of tutorial articles on the fundamentals of such important IC products as operational amplifiers, timers, phase-locked loops voltagecontrolled oscillators. These books are available directly from your Exar sales or technical representative.

A brief description of each of these data books is given below:

TIMER DATA BOOK:

This data book provides a collection of technical articles and application information on monolithic timer IC products. Also included are the data sheets and the detailed electrical specifications of all of Exar's timer circuits, including the programmable timer/counters, micropower and long-delay timers.

PHASE-LOCKED LOOP DATA BOOK:

This data book covers the fundamentals of design and applications of monolithic phase-locked loop (PLL) circuits. A long list of PLL applications are illustrated covering FM demodulation, frequency synthesis, FSK and tone detection. Particular emphasis is given to application of PLL circuits in data interface and communication systems such as FSK modems. This book also contains the data sheets and electrical specifications of all of Exar's PLL products.

FUNCTION GENERATOR DATA BOOK:

This comprehensive data book contains a number of technical articles and application notes on monolithic voltage-controlled oscillator (VCO) and function generator IC products. In addition, the data sheets and technical specifications of Exar's monolithic VCO's and function generators are given.

OPERATIONAL AMPLIFIER DATA BOOK:

This book contains a collection of technical articles on the fundamentals of monolithic IC op-amps. Some of the basic op-amp circuits are given, and the applications of IC op-amps in active filter design are discussed. The book also contains a complete set of electrical specifications in Exar's bipolar and BIFET op-amp products.

APPLICATIONS DATA BOOK:

This book contains a complete and up-to-date set of application notes prepared by Exar's technical staff. These application notes cover a wide range of subjects such as FSK modems, active filters, telecommunication circuits, electronic music synthesis and many more. In each case, specific design examples are given to demonstrate the applications discussed.

Ordering Additional Technical Literature from Exar

PRODUCT GUIDE:

A complete short-form catalogue of all of Exar's standard and custom products, quality assurance programs and technical capabilities. Key features and applications of each of Exar's products are given, along with their functional block diagrams, package types and operating temperature ranges. Products are grouped according to their applications, and a complete industry-wide cross reference chart is provided.

LINEAR AND DIGITAL SEMI-CUSTOM DESIGN BROCHURE:

This brochure contains a detailed description of Exar's unique bipolar and integrated injection logic (1^2L) semicustom design technology. Economic advantages of the semi-custom designs are discussed and economic guidelines are given for choosing the most cost-effective solution to a custom IC requirement. In addition, this brochure provides technical information on Exar's Master Chips and IC Design Kits.

APPLICATIONS DATA BOOK:

This book contains a complete and up-to-date set of application notes prepared by Exar's technical staff. These application notes cover a wide range of subjects such as FSK modems, active filters, telecommunication circuits, electronic music synthetics and many more. In each case, specific design examples are given to demonstrate the applications discussed. (\$2.95)

FUNCTION GENERATOR DATA BOOK:

This comprehensive data book contains a number of techni-

cal articles and application notes on monolithic voltagecontrolled oscillators (VCO) and function generator IC products. In addition, the data sheets and technical specifications of Exar's monolithic VCO's and function generators are given. (\$2.95)

OPERATIONAL AMPLIFIER DATA BOOK:

This book contains a collection of technical articles on the fundamentals of monolithic IC op amps. Some of the basic op amp circuits are given and the application of IC op amps in active filter design are discussed. The book also contains a complete set of electrical specifications in Exar's bipolar and BIFET op amp products. (\$2.95)

PHASE-LOCKED LOOP DATA BOOK:

This data book covers the fundamentals of design and applications of monolithic phase-locked loop (PLL) circuits. A long list of PPL applications are illustrated covering FM demodulation, frequency synthesis, FSK and tone detection. Particular emphasis is given to application of PLL circuits in data interface and communication systems such as FSK modems. This book also contains the data sheets and electrical specifications of all of Exar's PLL products. (\$2.95)

TIMER DATA BOOK:

This data book provides a collection of technical articles and application information on monolithic timer IC products. Also included are the data sheets and the detailed specifications of all of Exar's timer circuits, including the programmable timer/counters, micropower and long-delay timers. (\$2.95)

TECHNICAL LITERATURE REQUEST :

To obtain the technical literature of interest to you, contact the Exar sales representative nearest you, or write Exar, Integrated Systems Inc., P.O. Box 62229, Sunnyvale, CA 94088, on your company letterhead.

Data Books can also be ordered directly from Exar, at a nominal charge, by completing and sending this request card to Exar, with an appropriate check or money order (include \$2.00 for postage and handling). Please make checks payable to Exar Integrated Systems, Inc.

Please send me

🗆 Exar Product Guide – No Charge	Exar Semi-Custom Design Brochure – No Charge
□ Exar Applications Data Book: \$2.95	Exar Operational Amplifier Data Book: \$2.95
Exar Function Generator Data Book: \$2.95	Exar Phase-Locked Loop Data Book: \$2.95
Complete Set of Data Books: \$10.95	Exar Timer Data Book: \$2.95
Name	Title
Company/Agency	
Address	
City/State/ Zip	
	Company Manufactures

48

INTERNATIONAL SALES OFFICES AND REPRESENTATIVES

ARGENTINA

Rayo Electronics SRL Belgrando 990 Pisos 6Y2 Phone: 37 98 90 Telex: (390) 122153 (RAYOX AR)

AUSTRALIA

Total Electronics 310 Queen St. Melbourne G.P.O. Box 1286K Melbourne, 3001 Phone: 67 9306 Telex (790) 31261 (TOTELEC AA)

BELGIUM (See Germany)

BRASIL ROHM Do Brasil Industria Electronica Ltda. Av. Dom Pedro I, 420 01552 Sao Paulo Telex: (391) 1121178 (UIEL BR)

DENMARK

Mer-el A/S Ved Klædebo 18 DK-2970 Hørsholm Phone: 571000 Telex: (855) 37360 (MEREL DK)

FINLAND (Call Exar Direct)

FRANCE

Tekelec/Airtronic Rue Carle Vernet F-92310 Sevres Phone: (1) 534 75 35 Telex: (842) 204552 (TKLEC A)

GERMANY (WEST)

ROHM Electronics GmbH D-4051 Korschenbroich Muehlenstrasse 70 Phone: (02161) 29 805 Telex: (841) 852330 (ROHM D)

GREECE

General Electronics Ltd. 209 Thevon Street Nikaia 77, Piraeus Phone: 49 13 595 Telex: (863) 212949 (GELT GR)

HONG KONG

ROHM Electronics (H.K.) Co., Ltd. Rm 1027A, Ocean Centre 5, Canton Road, Tsimshatsui, Kowloon Phone: 3-688841/3-672307 Telex: (780) 37503 (REHCL HX)

INDIA

Zenith Electronics 541 Panchratna Mama Parmanand Marg Bombay 400004 Phone: 38 42 14 Telex: (953) 11 3152 (ZNTH IN)

ISRAEL CVS Technologies 1974 Ltd. 54 Jabotinsky Str. Ramat-Gan 52462 Phone: 330190 Telex: (922) 342369 (CVS IL)

ITALY

Eledra 3S S.p.A. Viale Elvezia, 18 20154 Milano Phone: 34.93.041 Telex: (843) 332332 (ELEDRA I)

JAPAN

Tokyo Electron Ltd. Panetron Division 38 FL Shinjuku Nomura Bldg. 1·26·2, Nishi-Shinjuku Shinjuku-ku, Tokyo 160 Phone: 03-343-4411 Telex: (781) 2322240 (LABTEL J)

LIECHTENSTEIN (See Switzerland)

LUXEMBOURG (See Germany)

NETHERLANDS

Tekelec/Airtronic B. V. Stork Staat 7 2722 NN Zoetermeer Phone: 079-310100 Telex: (844) 33332 (TKLEC NL)

NEW ZEALAND

Professional Electronics Ltd. 126 Kitchener Road Milford, Auckland 9 Phone: 46 94 50 Telex: (791) 21084 (PROTON)

NORWAY

Hefro Teknisk A/S Trondheimsveier 80 Oslo 5 Phone: 38 02 86 Telex: (856) 16205 (HEFRO N)

SING APORE

ROHM Electronics Co. Pte. Ltd. Unit G, Third Floor Cheng Chwee Huat Ind. Bldg. 118-D, Paya Lebar Road Singapore 1440 Phone: 2834327 Telex: (786) 26648 (ROHM S)

SOUTH AFRICA

South Continental Devices (Pty.) Ltd. Suite 516, 5th Floor, Randover House Cor. Hendrik Verwoerd, Dover Road Randburg, Transvaal Phone: 48 05 15 Telex: (960) 4-24849 (SA)

SPAIN

Unitronics, S. A. Princesa, 1 Madrid 8, Phone: 242 52-04 Telex: (831) 46786 (UTRON E)

SWEDEN

Lagercrantz Electronix AB Kanalvagen 5 S-194 01 Upplands Vasby Phone: (0760) 86 120 Telex: (854) 11275 (LAGER S)

SWITZERLAND

Amera Electronics AG Lerchenhaldenstrasse 73 CH-8046 Zurich Phone: (01) 57 11 12 Telex: (845) 59837 (AMERA CH)

TAIWAN (See Hong Kong)

UNITED KINGDOM

Thame Components Thame Park Road Thame, Oxon OX9 3RS Phone: (084 421) 3146 Telex: (851) 837917 (MEMEC G)

LATIN AMERICA

Intectra 2349 Charleston Road Mt. View, CA 94043 U.S.A. Phone: (415) 967-8818 Telex: 345545 (INTECTRA MNTV)

ALL OTHER COUNTRIES (Call Exar Direct)

DISTRIBUTOR

Finland Y leiselektroniikka/oy Atomitie 5B 00370 Helsinki 37 Phone: 90-562 1122 Telex: 123212 (Y LEOY SF)

AUTHORIZED STOCKING DISTRIBUTORS

ALABAMA Pioneer Electronics Huntsville (205) 837-9300

Resisticap, Inc. Huntsville (205) 881-9270

R. M. Electronics Huntsville (205) 852-1550

ARIZONA Bell Industries Tempe (602) 966-7800

Sterling Electronics Phoenix (602) 258-4531

ARKANSAS Carlton-Bates Co. Little Rock (501) 562-9100

CALIFORNIA Anthem Electronics Chatsworth (213) 700-1000

Anthem Electronics San Diego (714) 279-5200

Anthem Electronics San Jose (408) 946-8000

Anthem Electronics Tustin (714) 730-8000

Bell Industries Roseville (916) 969-3100

Bell Industries Sunnyvale (408) 734-8570

Diplomat Electronics Sunnyvale (408) 734-1900

JACO Chatsworth (213) 998-2200

VSI Electronics (USA) Inc. Santa Ana (213) 299-7760

Western Microtechnology Cupertino (408) 725-1664

Zeus West, Inc. Anaheim (714) 632-6880

COLORADO Bell Industries Wheatridge (303) 424-1985

50

Diplomat Electronics Denver (303) 427-5544 **CONNECTICUT** Diplomat Electronics Danbury (203) 797-9674

JV Electronics, Inc. East Haven (203) 469-2321

DELAWARE (See Pennsylvania)

FLORIDA Diplomat Southland Clearwater (813) 443-4514

Diplomat Southland Ft. Lauderdale (305) 971-7160

Diplomat Southland Palm Bay (305) 725-4520

GEORGIA (See Florida)

IDAHO (See Washington)

ILLINOIS Diplomat Electronics Bensenville (312) 595-1000

GBL-Goold Elk Grove Village (312) 593-3220

Intercomp Hoffman Estates (312) 843-2040

R. M. Electronics Lombard (312) 932-5150

INDIANA Altex Electronics, Inc. Carmel (317) 848-1323

Graham Electronics Indianapolis (317) 634-8202

R. M. Electronics Indianapolis (317) 247-9701

IOWA DEECO, Incorporated Cedar Rapids (319) 365-7551

KANSAS Component Specialties Lenexa (913) 492-3555

KENTUCKY (See Indiana)

LOUISIANA (See Texas)

MAINE (See New Hampshire)

MARYLAND

Diplomat Electronics Columbia (301) 995-1226

Pioneer Electronics Gaithersburg (301) 948-0710

MASSACHUSETTS Diplomat Electronics

Holliston (617) 429-4121

Gerber Electronics Norwood (617) 329-2400

RC Components Wilmington (617) 657-4310

MICHIGAN Ambur Electronics, Inc. Farmington Hills

(313) 477-8670 Diplomat Electronics

Farmington (313) 477-3200

R. M. Electronics Grand Rapids (616) 531-9300

MINNESOTA Diplomat Electronics Fridley (612) 572-0313

MISSISSIPPI (See Alabama)

MISSOURI Olive Industrial Elect. St. Louis (314) 426-4500

MONTANA (Call Exar Direct)

NEVADA (See California)

NEW HAMPSHIRE (See Massachusetts)

NEW JERSEY Diplomat Electronics Mount Laurel (609) 234-8080

Diplomat Electronics Totowa (201) 785-1830

NEW MEXICO Bell Industries Albuquerque (505) 292-2700

NEW YORK Diplomat Electronics Liverpool (315) 652-5000

Diplomat Electronics Melville (516) 454-6400

NEW YORK (Cont.) JACO

Hauppauge (516) 273-5500

Zeus Components, Inc. Port Chester (914) 937-7400

NORTH CAROLINA (See Maryland)

NORTH DAKOTA (Call Exar Direct)

OHIO Component Elect., Inc. Brunswick (216) 225-3401

Graham Electronics Cincinnati (513) 772-1661

OKLAHOMA Component Specialties Tulsa (918) 664-2820

Radio, Inc. Tulsa (918) 587-9123

Quality Components Tulsa (918) 664-8812

OREGON Bell Industries Lake Oswego (503) 241-4115

Radar Electric Co., Inc. Portland (503) 233-3691

PENNSYLVANIA Advacom

Erie (814) 476-7774

Pioneer Electronics Horsham (215) 674-4000

RHODE ISLAND (See Massachusetts)

SOUTH CAROLINA (See Maryland)

SOUTH DAKOTA (Call Exar Direct)

TENNESSEE (See Alabama)

TEXAS Component Specialties Austin (512) 837-8922

Component Specialties Dallas (214) 357-6511

Component Specialties Houston (713) 771-7237 TEXAS (Continued) Quality Components Addison (214) 387-4949

Quality Components Austin (512) 835-0220

Quality Components Houston (713) 772-7100

UTAH Bell Industries Salt Lake City (801) 972-6969

Diplomat Electronics Salt Lake City (801) 486-4134

VERMONT (See New Hampshire)

VIRGINIA (See Maryland)

WASHINGTON JACO Bellevue (206) 455-2727

Radar Electric Co., Inc. Seattle (206) 282-2511

Western Electromotive Seattle (206) 575-1910

WISCONSIN Taylor Electric Co. Mequon (414) 241-4321

WYOMING (See Colorado)

CANADA Future Electronics Point Claire, Quebec (514) 694-7710

Intek Electronics Ltd. Vancouver, B.C. (604) 324-6831

R-A-E Industrial Elect. Burnaby, B.C. (604) 291-8866

Cam Gard Supply Ltd. Calgary, Alberta (403) 287-0520

Cam Gard Supply Ltd.

Cam Gard Supply Ltd.

Cam Gard Supply Ltd.

Cam Gard Supply Ltd.

Winnipeg, Manitoba

Saskatchewan

(306) 652-6424

Toronto, Ontario

(416) 252-5031

Vancouver, B. C.

(604) 291-1441

(204) 786-8401

Saskatoon,

AUTHORIZED REPRESENTATIVES

ALABAMA

Rep, Incorporated 11527 S. Memorial Parkway. Huntsville, AL 35803 (205) 881-9270 TWX 810-726-2102

ALASKA (Call Exar Direct)

ARIZONA Summit Sales 7825 E. Redfield Road Scottsdale, AZ 85260 (602) 998-4850 TWX 910-950-1283

ARKANSAS (See Oklahoma)

CALIFORNIA (NO.) Criterion 3350 Scott Blvd., Bldg. 44 Santa Clara, CA 95051 (408) 988-6300 TWX 910-338-7352

CALIFORNIA (SO.) Varigon Associates 137 Eucalyptus Drive El Segundo, CA 90245 (213) 322-1120 TWX 910-348-7141

Varigon/ARC 2356 Moore St., Suite 103 San Diego, CA 92110 (714) 299-5413

COLORADO

Waugaman Assoc., Inc. 4800 Van Gordon St. Wheatridge, CO 80033 (303) 423-1020 TWX 910-938-0750

CONNECTICUT Phoenix Sales

389 Main Street Ridgefield, CT 06877 (203) 438-9644 TWX 710-467-0662

DELAWARE (See Maryland)

FLORIDA

Donato & Assoc., Inc. 2660 West Oakland Park Blvd. Suite 210 Ft. Lauderdale, FL 33311 (305) 733-3450 TWX 510-955-9789

GEORGIA Rep, Incorporated 1944 Cooledge Road Tucker, GA 30084 (404) 938-4358 TWX 810-766-0822

HAWAII (Call Exar Direct)

IDAHO (See Washington)

INDIANA

(See Ohio)

Suite 201

KANSAS

52402

Dytronix, Inc.

NorthEast

Cedar Rapids, IA

(319) 377-8275

(See Missouri)

KENTUCKY

LOUISIANA

MARYLAND

(301) 484-3647

(See Massachusetts)

Component Sales Inc.

Baltimore, MD 21208

TWX 710-862-0852

MASSACHUSETTS

101 Cambridge Street

Burlington, MA 01803

TWX 710-332-6569

Contact Sales, Inc.

(617) 273-1520

MICHIGAN

MINNESOTA

Dan'l Engineering

(612) 435-6000

12350 W. 175th St.

Lakeville, MN 55044

(See Ohio)

3701 Old Court Rd.

(See Texas)

MAINE

Suite 14

(See Ohio)

23 Twixt Town Road

IOWA

ILLINOIS (NORTH) Janus, Incorporated 3166 Des Plaines Ave. Suite 14 Des Plaines, IL 60018 (312) 298-9330

NEBRASKA ILLINOIS (SOUTH) (See Missouri) (See Missouri)

NEVADA (See California No.)

MISSISSIPPI

MISSOURI

(See Alabama)

Dy-Tronix, Inc.

(314) 731-5799

Dy-Tronix, Inc.

Suite 202

64055

MONTANA

(See Colorado)

11190 Natural Bridge

Bridgeton, MO 63044

13700 E. 42nd Terrace

TWX 910-762-0651

Independence, MO

(816) 373-6600

NEW HAMPSHIRE (See Massachusetts)

NEW MEXICO Syntech 302C San Pablo S.E. Albuquerque, NM 87108 (505) 266-7951

NEW JERSEY (NO.) (See New York City)

NEW JERSEY (SO.) (See Pennsylvania)

NEW YORK (UPSTATE) Quality Components

3343 Harlem Road Buffalo, NY 14225 (716) 837-5430

Quality Components 116 E. Fayette St. Manlius, NY 13104 (315) 682-8885 TWX 710-545-0663

NEW YORK (CITY) E RA, Incorporated 354 Veterans Memorial Hwy. Commack, NY 11725 (516) 543-0510 In NJ: 800-645-5500/1

TWX 510-226-1485

NORTH CAROLINA Component Sales, Inc. P.O. Box 18821 Raleigh, NC 27619 (919) 782-8433 TWX 510-928-0513

NORTH DAKOTA

(See Minnesota)

OHIO

McFadden Sales 4645 Executive Drive Columbus, OH 43220 (614) 459-1280 TWX 810-482-1623

OKLAHOMA (See Texas)

OREGON SD-R² Products & Sales 1526 S.E. Claybourne Portland, OR 97202 (503) 231-7638

PENNSYLVANIA (WEST)

(See Ohio)

PENNSYLVANIA (EAST)

Vantage Sales Company 21 Bala Avenue Bala Cynwyd, PA 19004 (215) 667-0990 TWX 510-662-5846

RHODE ISLAND (See Massachusetts)

SOUTH CAROLINA (See North Carolina)

SOUTH DAKOTA (See Minnesota)

TENNESSEE

Rep, Incorporated 113 S. Branner Ave. Jefferson City, TN 37760 (615) 475-4105 TWX 810-570-4203

TEXAS

Technical Marketing 9027 Northgate Blvd. Suite 140 Austin, TX 78758 (512) 835-0064

Technical Marketing 3320 Wiley Post Road Carrollton, TX 75006 (214) 387-3601 TWX 910-860-5158

Technical Marketing 6430 Hillcroft Suite 104 Houston, TX 77081 (713) 777-9228

UTAH

Waugeman Assoc., Inc. 2520 S. State, Ste. 159 Salt Lake City, UT 84118 (801) 467-4263 TWX 910-925-4026

VERMONT (See Massachusetts)

VIRGINIA (See Maryland)

WASHINGTON

SD-R² Products & Sales 14230 NE 8th Street Bellevue, WA 98007 (206) 747-9424 TWX 910-443-2483

WASHINGTON, D.C. (See Maryland)

WEST VIRGINIA (See Ohio)

WISCONSIN (S. EAST) Janus, Incorporated

11430 Bluemound Rd. Milwaukee, WI 53026 (414) 476-9104

WISCONSIN (WEST) (See Minnesota)

WYOMING (See Colorado)

CANADA (EAST)

R.F.Q. Limited 385 The West Mall Suite 251 Etobicoke, Ontario M9C 1E7 (416) 626-1445 TWX 610-492-2540

R.F.Q. Limited 2249 Carling Avenue Suite 204 Ottawa, Ontario K2B 7E9 (613) 820-8445/8446 TWX 610-562-1973

